

*T<sub>c</sub>'s higher than the one of Nb for the RF*



# **A Super-Superconductor**

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**and**

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*Argonne National Laboratories,IL, Sept 21 2004*

At a given angular frequency  $\omega$ , the surface impedance  $Z_n$  for a **normal metal**, in the normal regime, can be written as

$$Z_n = \frac{1 - i}{\sigma_n \delta} = (1 - i) \frac{\rho_n}{\delta}$$

where  $\sigma_n = 1 / \rho_n$  is the dc conductivity at the working temperature;  
 $\delta$  is the skin depth

Extension to Superconductors:

$\sigma_1 - i \sigma_2$  in place of  $\sigma_n$

As derived by Nam, for  $T < T_c / 2$

$R_s$  can be approximated by

$$\frac{R_s}{R_n} = \frac{1}{\sqrt{2}} \frac{\sigma_1 / \sigma_n}{\left(\sigma_2 / \sigma_n\right)^{3/2}}$$

In the framework of the BCS theory extension at finite frequencies, Mattis and Bardeen found, for  $\omega < 2 \Delta$ , the two following integral relations for the complex conductivity of a superconductor:

$$\frac{\sigma_1}{\sigma_n} = \frac{2}{h' \omega} \int_{\Delta}^{\infty} (f(E) - f(E + h' \omega)) g^+(E) dE$$

$$\frac{\sigma_2}{\sigma_n} = \frac{1}{h' \omega} \int_{\Delta - h' \omega, -\Delta}^{\Delta} (1 - 2 f(E + h' \omega)) g^-(E) dE$$

$$2 \Delta = s K T_C,$$

$$f(E) = \frac{1}{\left(1 + e^{E/KT}\right)}$$

$$g^{\pm}(E) = \frac{E^2 + \Delta^2 + h'\omega E}{\left(\pm (E^2 - \Delta^2)\right)^{1/2} \left((E + h'\omega)^2 - \Delta^2\right)^{1/2}}$$

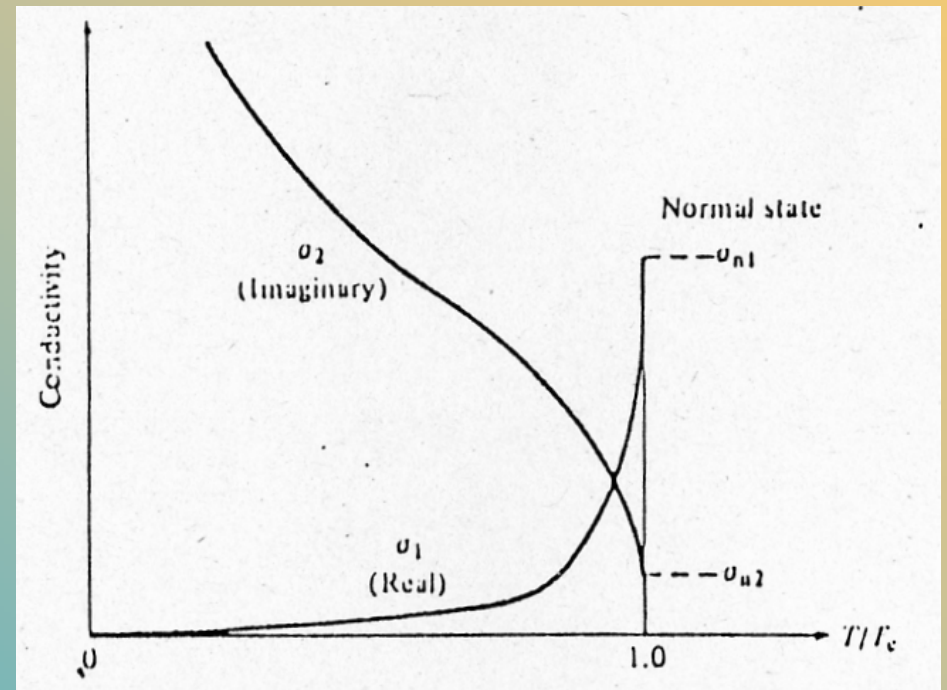
The two integrals  $\sigma_1/\sigma_n$  and  $\sigma_2/\sigma_n$  are easily numerically calculated.

In the normal skin effect regime, for  $\hbar\omega \ll 2\Delta$

they can be approximated by two analytical expressions:

$$\frac{\sigma_1}{\sigma_n} = \left[ \frac{2\Delta/KT}{\left(1 + e^{-\Delta/KT}\right)^2} \right] e^{-\Delta/KT} \ln \frac{\Delta}{\hbar\omega}$$

$$\frac{\sigma_2}{\sigma_n} = \frac{\pi\Delta}{\hbar\omega} \tanh \frac{\Delta}{2KT}$$



Then, if  $T < T_c / 2$

$$R_{\text{BCS}} \cong \frac{R_n}{\sqrt{2}} \left( \frac{h' \omega}{\pi \Delta} \right)^{3/2} \frac{\sigma_1}{\sigma_n} = A \rho_n^{1/2} \frac{e^{-\frac{\Delta}{KT_c}}}{\sqrt{s T_c T} \left( 1 + e^{-\frac{\Delta}{KT_c}} \right)^2} \omega^2 \ln \frac{\Delta}{h' \omega}$$

with  $A = 6 \cdot 10^{-21} \left[ \frac{\Omega K^3}{\text{ms}^4} \right]^{1/2}$

**For low rf losses, a high  $T_c$  value it is not sufficient**

**A metallic behaviour is mandatory**

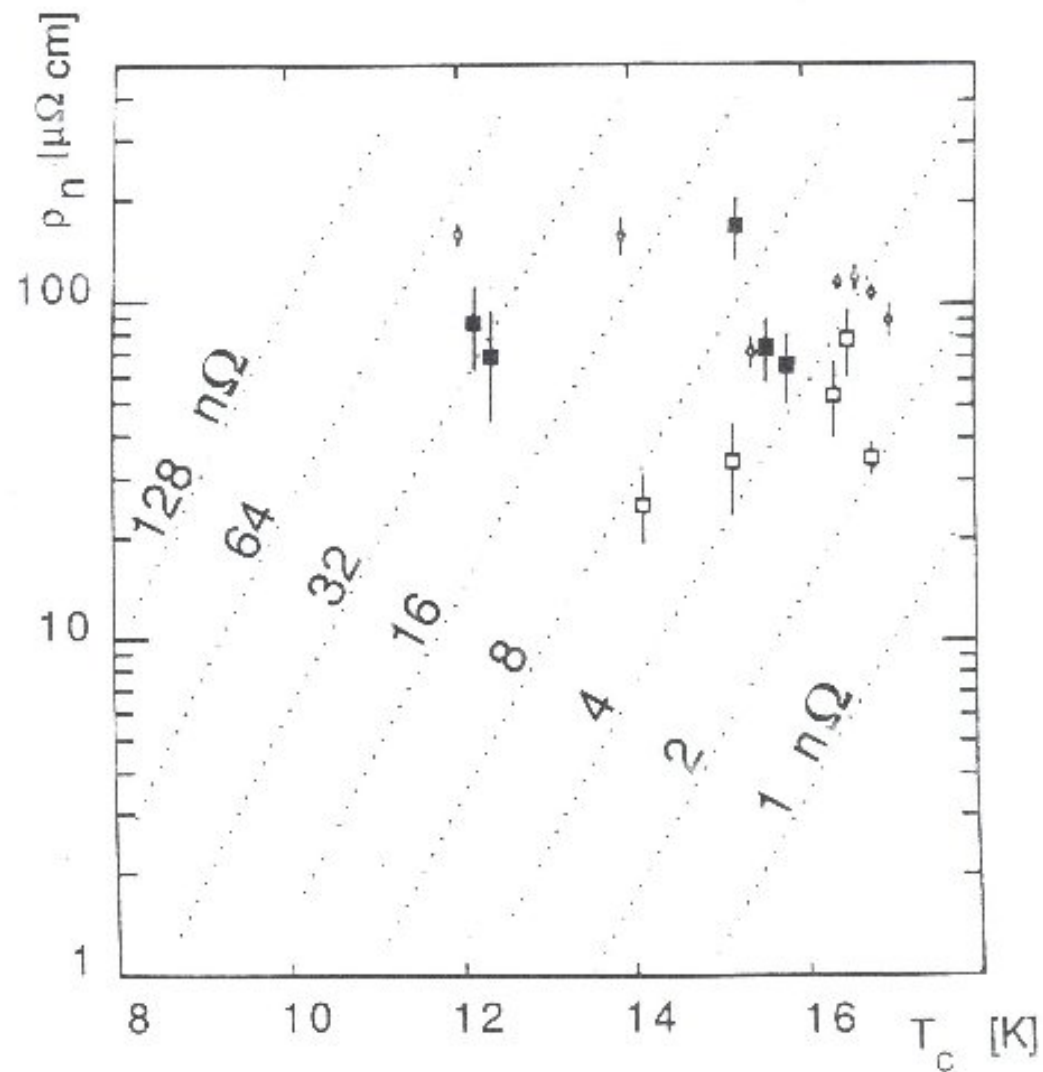
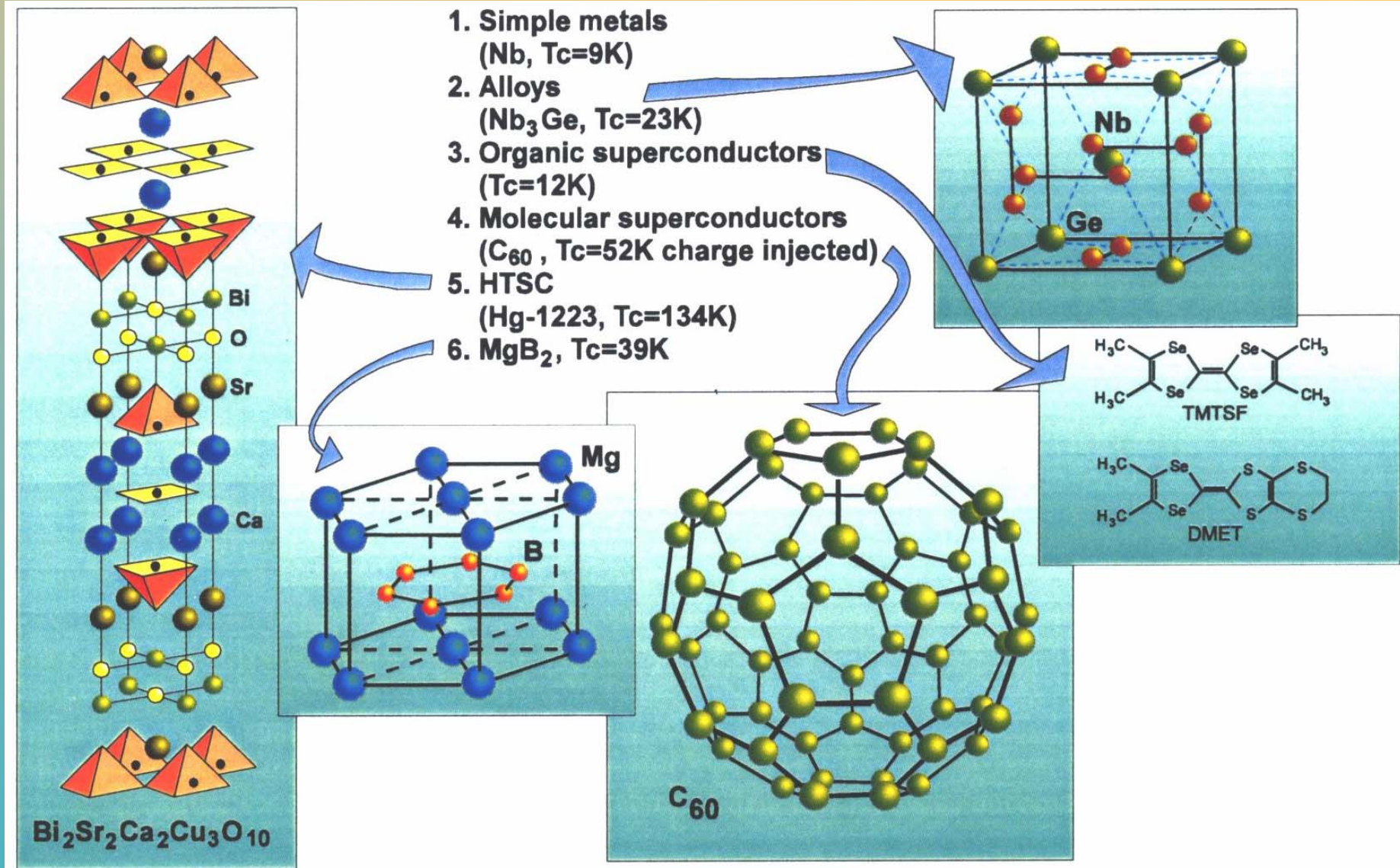


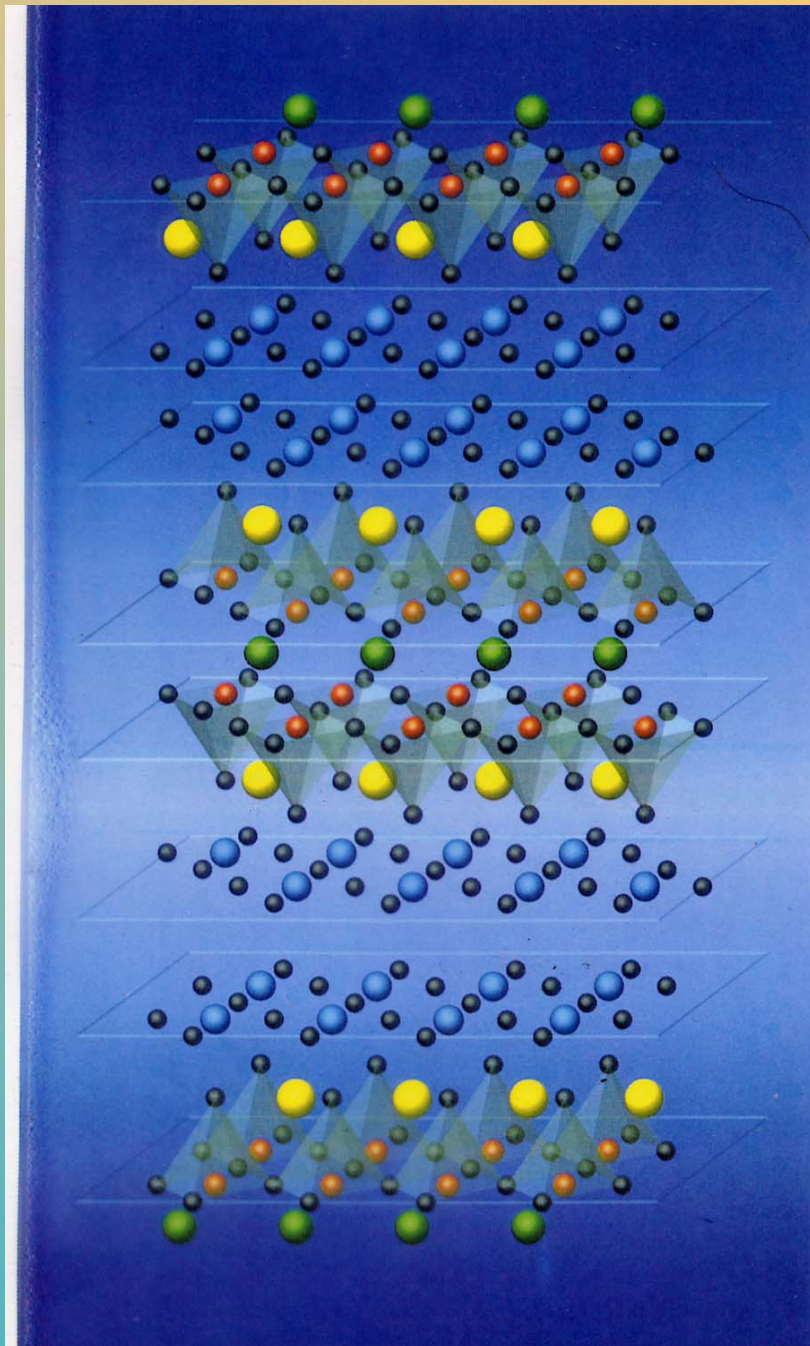
Fig 1 Lines of equal  $R_{BCS}$  at 4.2 K and 500 MHz in the bidimensional space  $(\rho_n, T_c)$ . Fixed the working temperature ( $T = 4.2$  K), and the frequency ( $f = 500$  MHz),  $R_{BCS}$  depends only on the energy gap and on the normal state resistivity. The  $T_c$  scale is draft for the case  $s = 4$ . For comparison Nb coated cavities provide  $R_{BCS} = 55$  n $\Omega$ . The experimental data refer to: sputtered films of (NbTi)N at 200 C (full square); (NbTi)N at 600 C (empty square); NbN at 200 C





**Different classes of superconductors (after Buzea and Yamashita).**





*Fig. 1  
Crystal structure of the  
superconductor type Bi<sub>2</sub>  
(Sr<sub>1-y</sub>Ca<sub>y</sub>)<sub>3</sub>  
Cu<sub>2</sub>O<sub>10-δ</sub> developed by  
Hoechst.  
Key: green =  
calcium (Ca),  
red = copper  
(Cu), black =  
oxygen (O),  
yellow = stron-  
tium (Sr), blue  
= bismuth  
(Bi).*

**PERCOLATION, SURFACE IMPEDANCE and PINNING in MgB<sub>2</sub>-, and HTS-SUPERCONDUCTORS.**

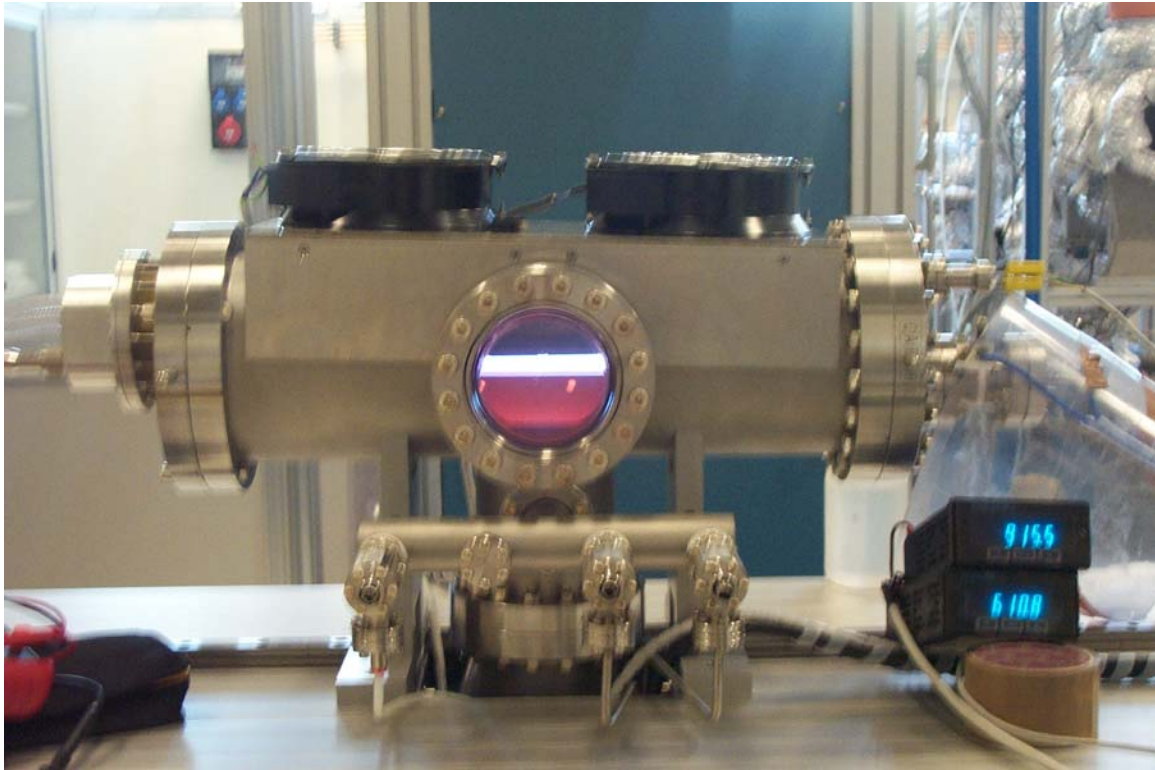
**J. Halbritter, Forschungszentrum Karlsruhe  
Institut für Materialforschung  
Postfach 36 40  
76021 Karlsruhe**

**ABSTRACT**

The hindrance of electric transport by grain/island boundary resistances  $R_{bn}$  ( $\Omega\text{cm}^2$ ) in distances  $a_J$  ( $\lesssim 1\mu\text{m}$ ) is well accepted in the normal conducting transport in granular materials. In contrast, in superconducting transport such boundaries enhance by the related critical Josephson current density  $j_{cJ}$  the critical current density by Josephson fluxons (JF). For a quantitative model the resistivity

$$\rho(T) = R_{bn}/a_J + p (\rho^i(T) + \rho^i(0))$$

is fitted to observations with percolation factors  $p > 1$  by current diverting boundaries with  $R_{bn} \gtrsim m\Omega\text{cm}^2$ . HTS show  $p > 1 - 10$ , critical current densities  $j_c(H < H_{c1}) \simeq j_{cJ}(H)$  by JF pinning with  $j_{cJ}R_{bn} \approx 10^{-12} \text{V}\Omega\text{m}^2/R_{bn} \ll \Delta/e$ , rf residual losses  $R_{res} \propto \omega^2/a_J j_{cJ}^{3/2} R_{bn}$  and hysteresis losses  $R_{hys} \propto \omega H/a_J j_{cJ}$ . In MgB<sub>2</sub> films percolation with  $p \gtrsim 2 - 50$ , with  $j_c(H < H_{c1}) \simeq j_{cJ}(H)$  and  $j_{cJ}R_{bn} \approx \Delta/e$  is found. Whereas percolation decreases conductivities via the boundary resistances  $R_{bn}$  in the normal state always, pinning of JF enhances  $j_c(H < H_{c1}) \simeq j_{cJ}(H)$  dominated in dc transport by chains of strongest links. In contrast, rf surface impedances via  $R_{res}(T, \omega) \propto \omega^2/j_{cJ}(T)^{3/2}$  and  $R_{hys}(T, H) \propto \omega H/j_{cJ}(T)$  are dominated by the weakest links and deteriorate by weak links always. But in all cases where  $\rho(T)$  deviates from Matthiessen law, RRR values are not sufficient to describe material quality, but a proper percolation analysis is needed to forecast via  $R_{bn} \propto j_{cJ}^{-n}$  ( $n \simeq 1 - 2$ ) superconducting properties below  $H_{c1}$  in dc and rf.

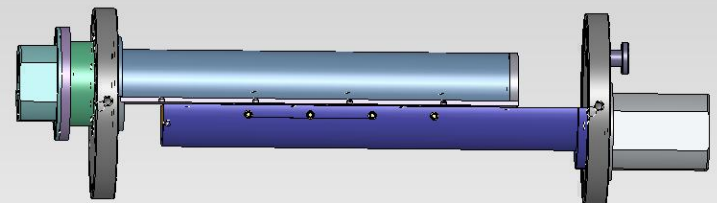


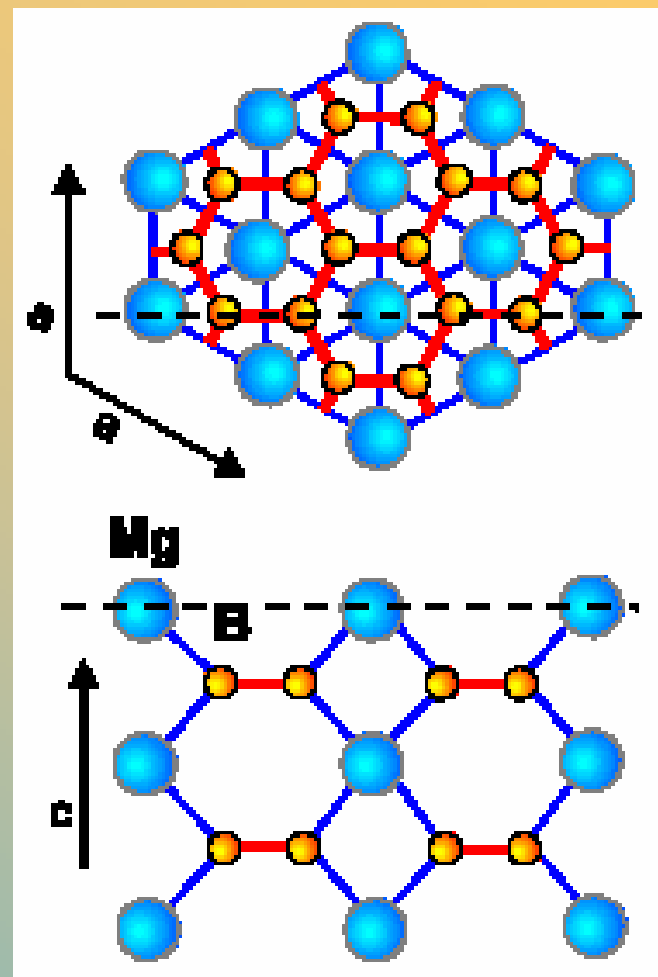
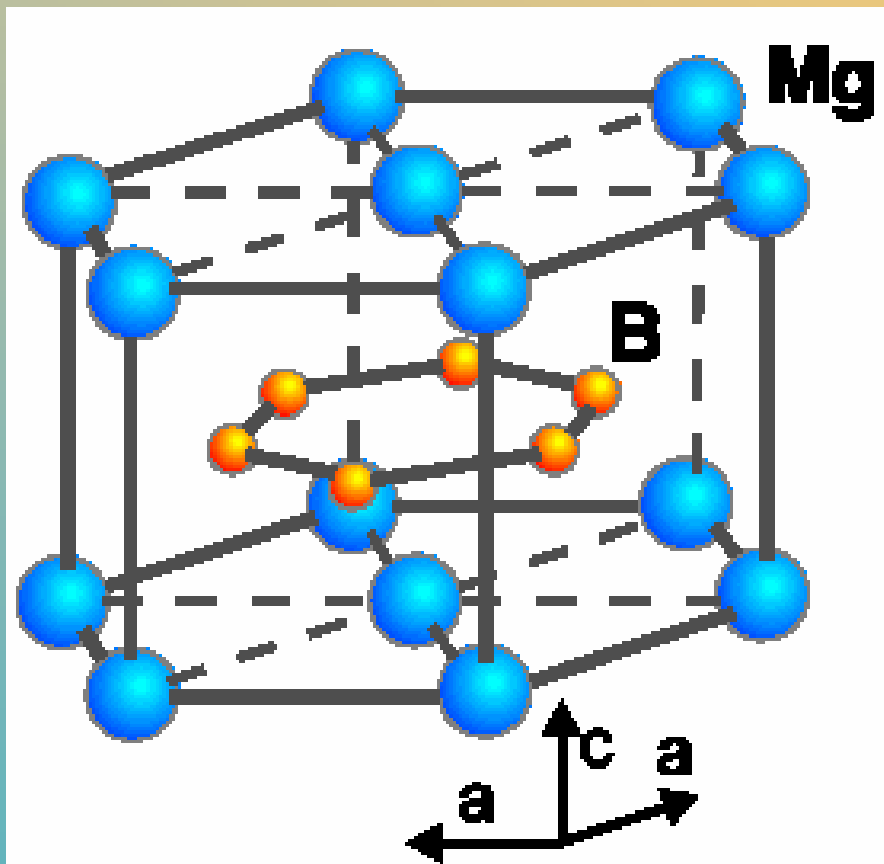
## YBCO thin films on large area substrates

P.Romano, A. Vecchione,  
G. Keppel and V. Palmieri

**DIODE** Sputtering at **950 C** at **1 mbar**  
onto sapphire, and SrTiO<sub>3</sub>

**Distance cathode substrate = 10 mm**





Structure of  $\text{MgB}_2$  containing graphite-type B layers separated by hexagonal close-packed layers of Mg  
(After Buzea and Yamashita)

# And what about the problem of film degradation due to water exposure???

Activity on MgB<sub>2</sub> at Los Alamos Neutron Science Center

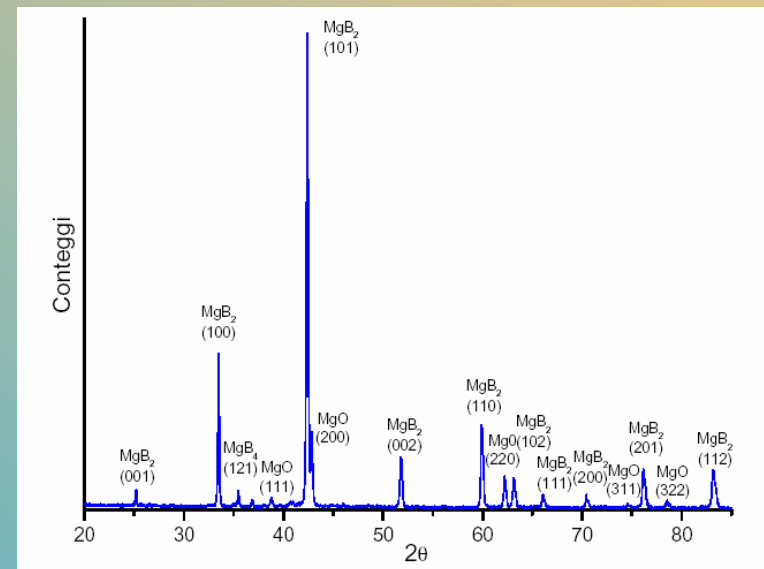
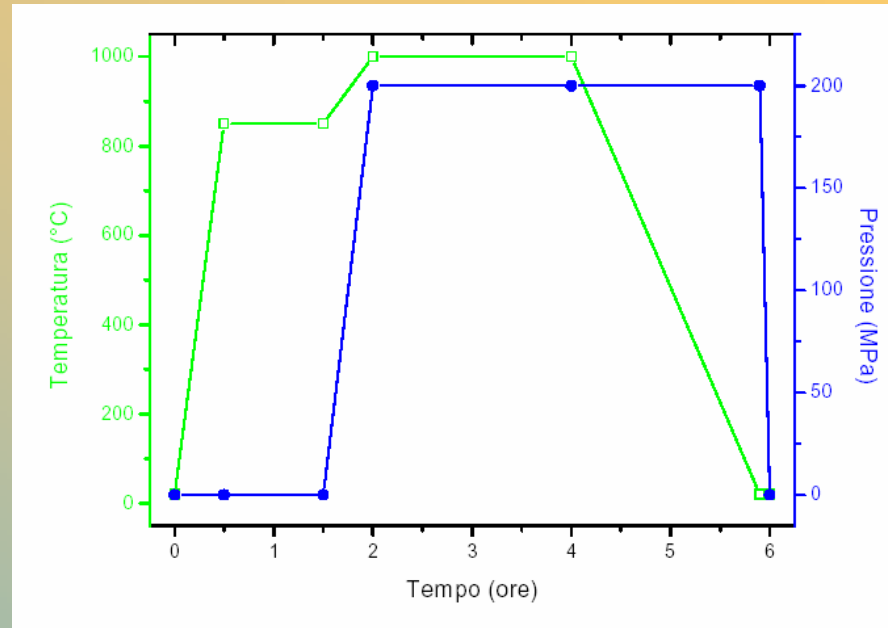
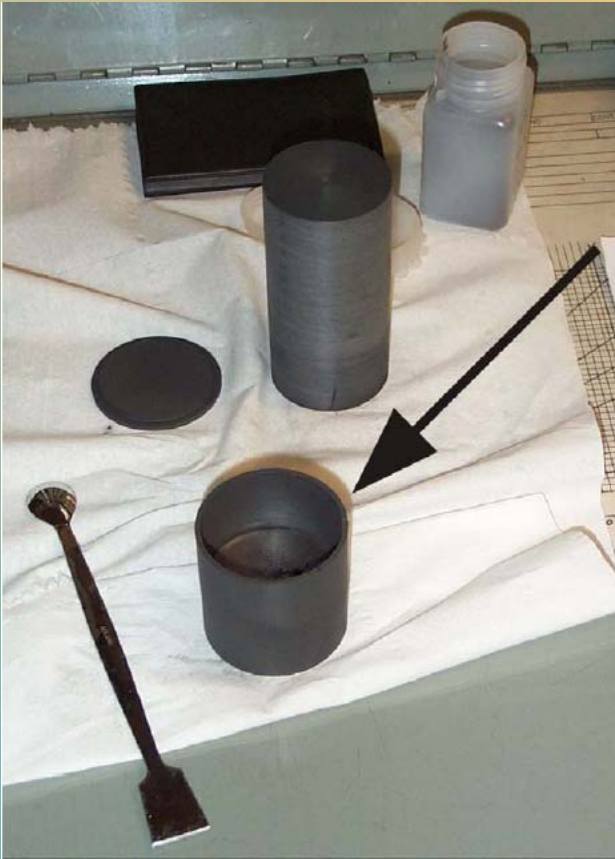
Report by **Tsuyoshi Tajima**

## Bulk samples by HIP

- No degradation with high-pressure water rinse
- Surface polishing with 0.1mm diamond lapping paper reduced Rs significantly



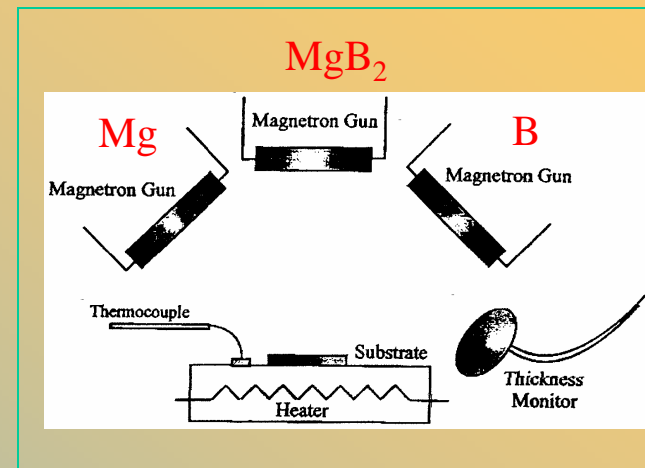
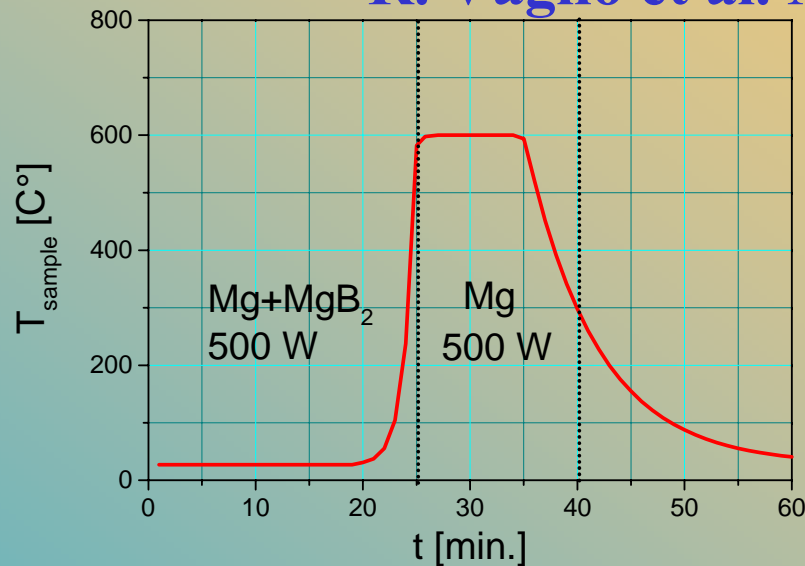
Giorgio Keppel, Thesis 2004,  
Material Science Dept, Padua University





# DC Magnetron Sputtering of $\text{MgB}_2 + \text{Mg}$

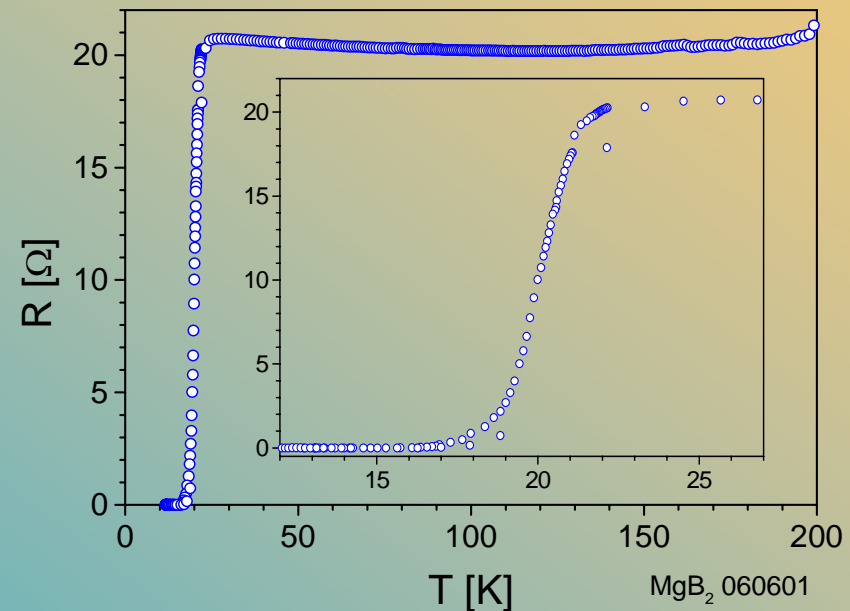
R. Vaglio et al. Naples University



Films are deposited by an in-situ process in two steps:

DC Magnetron Sputtering of  $\text{MgB}_2$  and Mg targets at room temperature

Post-annealing at increasing temperature (300°C - 600°C) in Mg sputtering

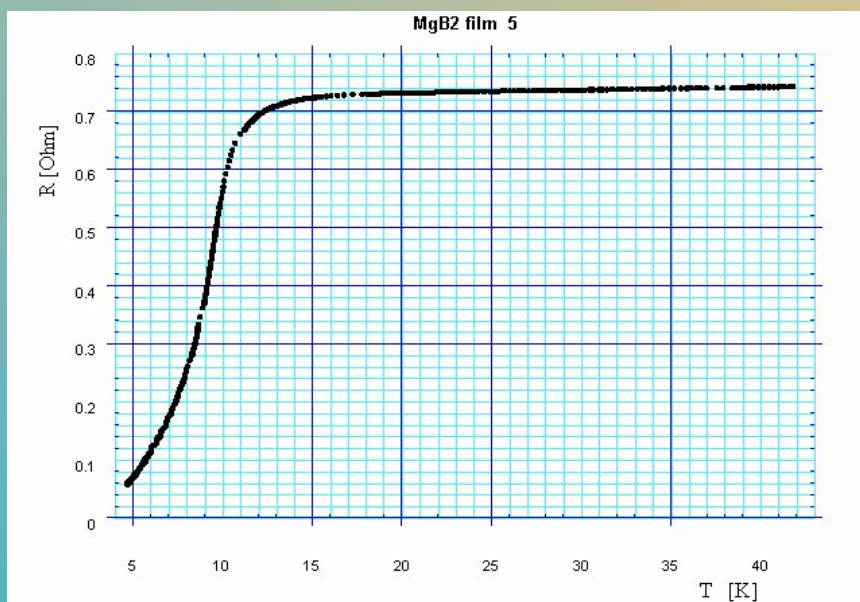


# DC Pulsed Sputtering of $\text{MgB}_2$ + Mg Powders

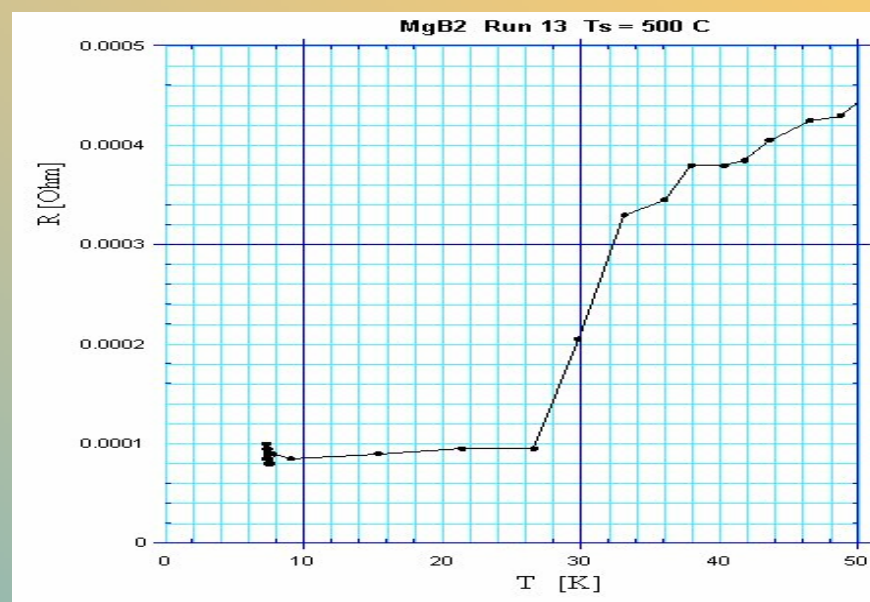
V. Palmieri, A. Calore, I.I. Kulik

**Advantages:** The added Mg compensates the lost one. Targets are self-made. One can immediately prepare targets out of stoichiometry or with the addition of other elements.

**Disadvantages:** Possible leaking of Magnesium during the sputtering process.



Room temperature substrate

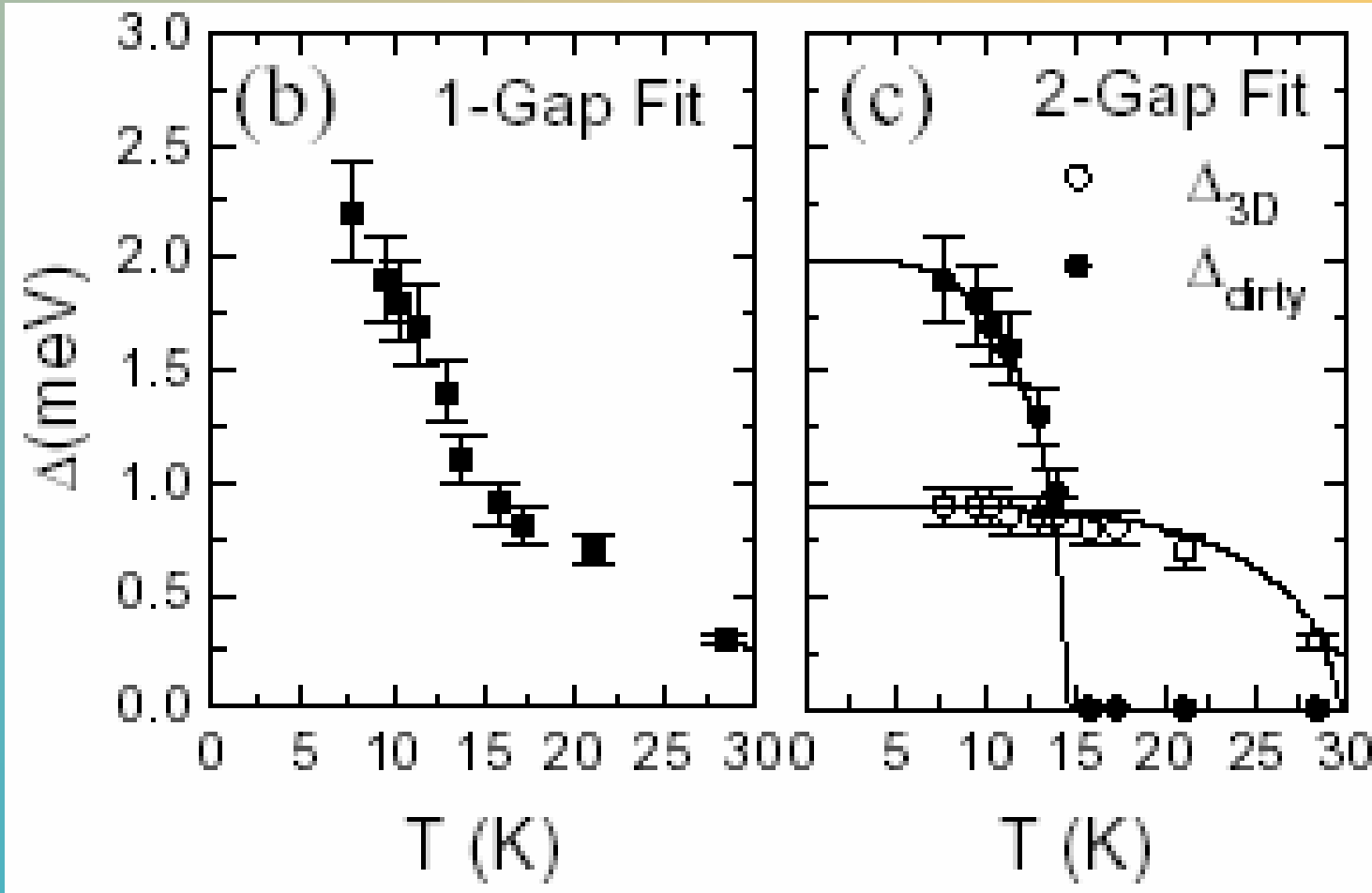


Substrate Temperature = 500 C

**No Postannealing**

T-dependence of the order parameter from fit with the one-gap model.  $\Delta_{\text{dirty}}(T)$  and  $\Delta_{3D}(T)$  from fit with the two-gap model. Fit to BCS curves

T-dependence of the order parameter from fit with the one-gap model.  $\Delta_{\text{dirty}}(T)$  and  $\Delta_{3D}(T)$  from fit with the two-gap model. Fit to BCS curves



(after G. Carapella, N. Martucciello, G. Costabile, C. Ferdeghini, V. Ferrando, and G. Grassano)

# Gap parameters

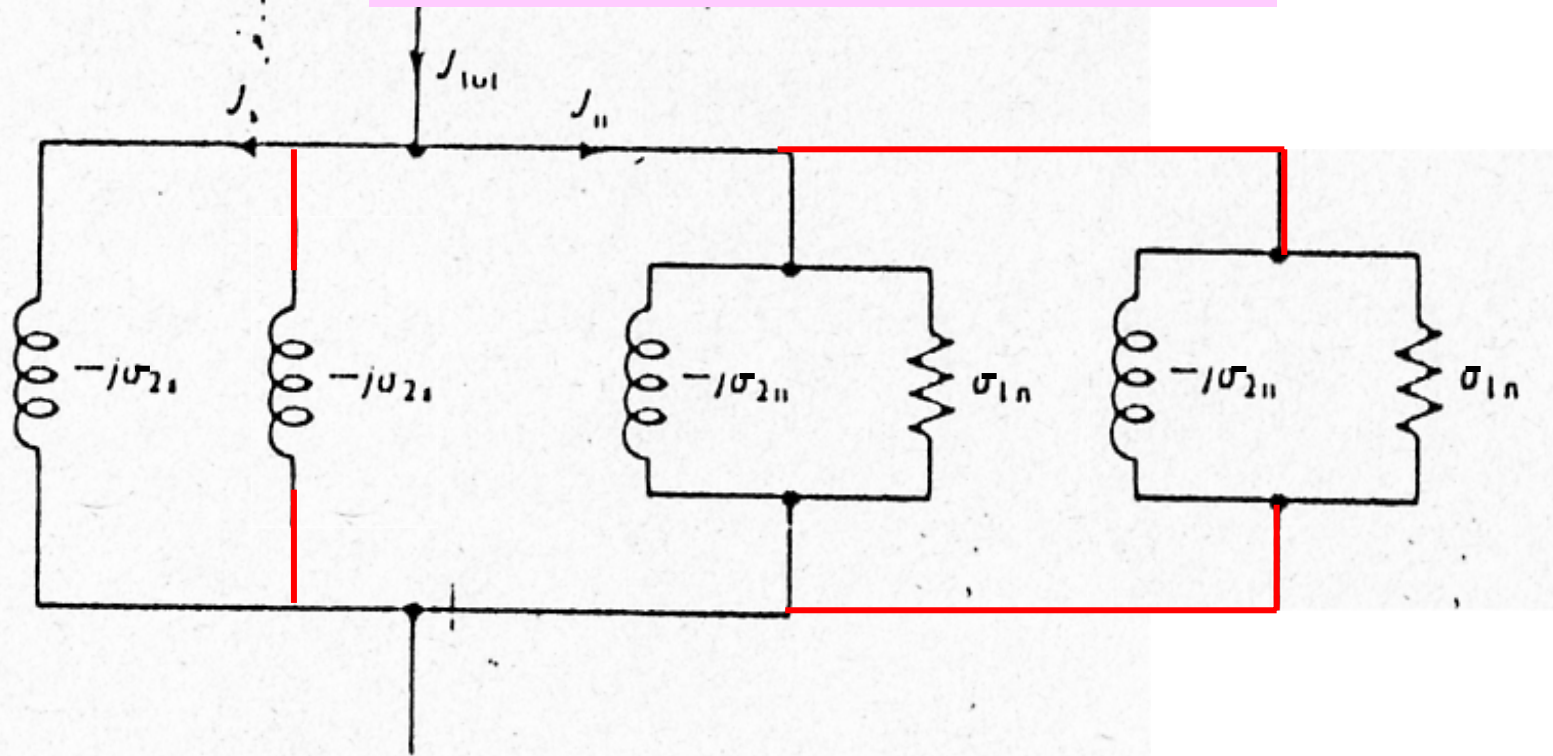
from specific heat and spectroscopic experiments:

Technique	$2\Delta_1(0)/k_B T_c$	$2\Delta_2(0)/k_B T_c$	$\gamma_1 : \gamma_2$
specific heat	3.8	1.3	0.5:0.5
specific heat	3.9	1.3	0.5:0.5
specific heat	4.4	1.2	0.55:0.45
penetration depth	4.6	1.6	0.60:0.40
tunneling	4.5	1.9	
Raman	3.7	1.6	
point-contact	4.1	1.7	
photoemission	3.6	1.1	
band structure	4	1.3	0.53:0.47

(After A. Junod, Y. Wang, J.F. Bouquet, P. Toulemonde)

# Two fluid model

# Three fluid model



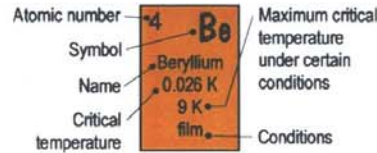
Equivalent circuit for the admittance of a unit cube of superconductor



# PERIODIC TABLE OF SUPERCONDUCTING ELEMENTS

from Yamashita T, Nakajima K, Chen J, Buzea C,  
**Superconductors - Scientific Basics and Engineering Applications**  
 (Springer-Verlag, Heidelberg) 2002

- Superconducting element
- Nonsuperconducting element
- Superconducting element only under pressure or in film form

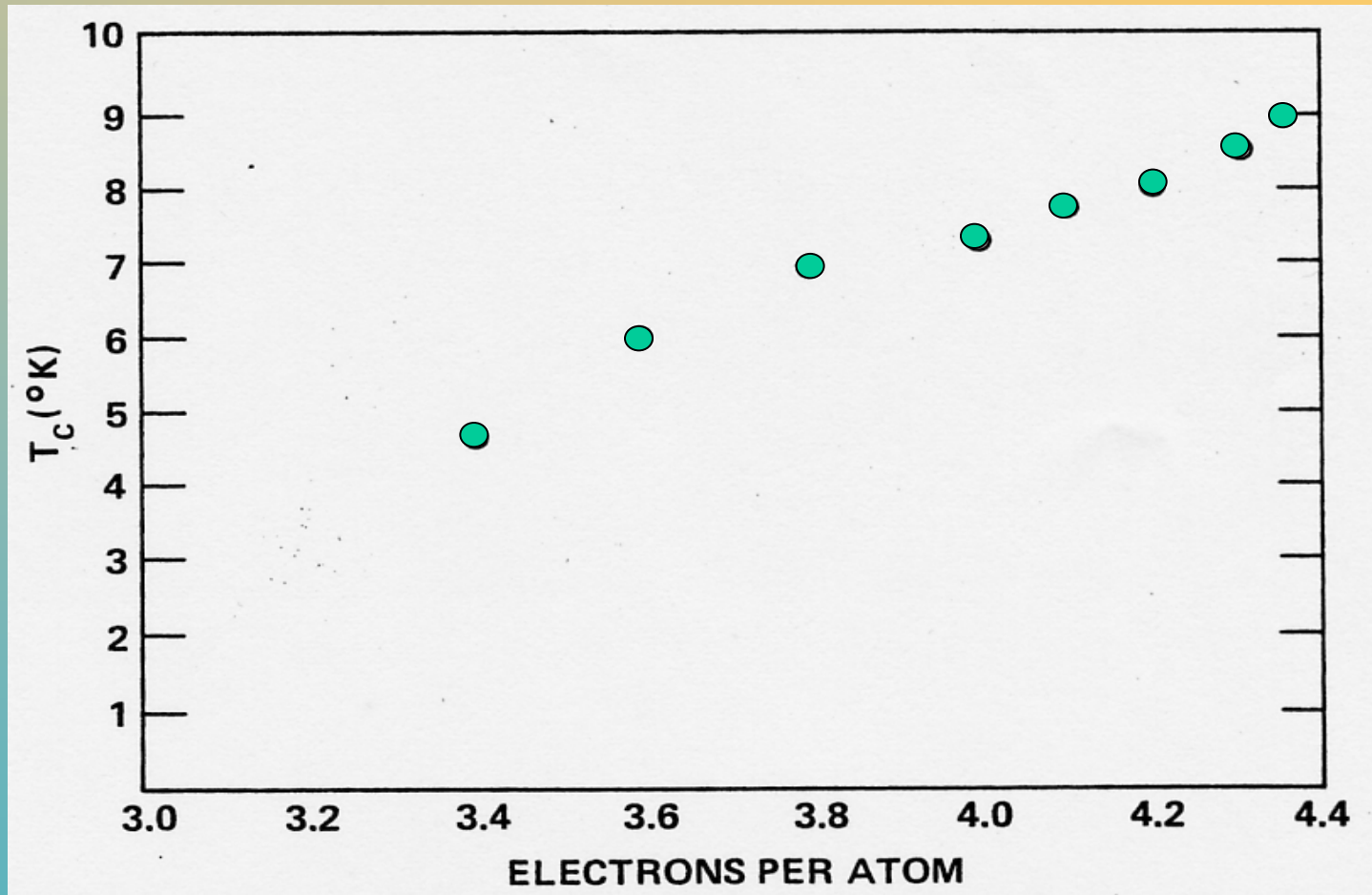


IA										VIII																		
1 H Hydrogen									2 He Helium																			
IIA												IIIB		IVB		VB		VIB		VIIB								
3 Li Lithium 7 K 26 GPa	4 Be Beryllium 0.026 K 9 K film											5 B Boron 11.2 K 250 GPa	6 C Carbon 52 K charge doped	7 N Nitrogen	8 O Oxygen 0.6 K 120 GPa	9 F Fluorine	10 Ne Neon											
11 Na Sodium	12 Mg Magnesium											13 Al Aluminum 1.17 K 3.6 K film	14 Si Silicon 8.5 K 12 GPa	15 P Phosphorus 5.8 K 17 GPa	16 S Sulfur 17 K 160 GPa	17 Cl Chlorine	18 Ar Argon											
		IIIA		IVA		VA		VIA		VIIA		VIII A				IB		IIB										
19 K Potassium	20 Ca Calcium 15 K 150 GPa	21 Sc Scandium	22 Ti Titanium 0.4 K	23 V Vanadium 5.4 K 17.2 K 120 GPa	24 Cr Chromium film	25 Mn Manganese film	26 Fe Iron 2 K 21 GPa	27 Co Cobalt	28 Ni Nickel	29 Cu Copper	30 Zn Zinc 0.85 K	31 Ga Gallium 7.9 K 8.4 K film	32 Ge Germanium 5.4 K 11.5 GPa	33 As Arsenic 2.7 K 24 GPa	34 Se Selenium 7 K 13 GPa	35 Br Bromine 1.4 K 150 GPa	36 Kr Krypton											
37 Rb Rubidium	38 Sr Strontium 4 K 50 GPa	39 Y Yttrium	40 Zr Zirconium 0.6 K	41 Nb Niobium 9.25 K 9.7 K 4.5 GPa	42 Mo Molybdenum 0.92 K	43 Tc Technetium 8.2 K	44 Ru Ruthenium 0.5 K	45 Rh Rhodium 0.035 mK	46 Pd Palladium film/irrad	47 Ag Silver	48 Cd Cadmium 0.52 K	49 In Indium 3.4 K 4.2 K film	50 Sn Tin 3.7 K 4.7 K film	51 Sb Antimony 3.8 K 8.5 GPa	52 Te Tellurium 7.4 K 35 GPa	53 I Iodine 1.2 K 25 GPa	54 Xe Xenon											
55 Cs Cesium 1.5 K 5 GPa	56 Ba Barium 5 K 15 GPa			72 Hf Hafnium 0.16 K	73 Ta Tantalum 4.4 K	74 W Tungsten 0.01 K 5.5 K film	75 Re Rhenium 1.7 K	76 Os Osmium 0.7 K	77 Ir Iridium 0.1 K	78 Pt Platinum	79 Au Gold	80 Hg Mercury 4.15 K	81 Tl Thallium 2.4 K	82 Pb Lead 7.2 K	83 Bi Bismuth 8.7 K 9 GPa	84 Po Polonium	85 At Astatine	86 Rn Radon										
87 Fr Francium	88 Ra Radium																											
		IIIA		IVA		VA		VIA		VIIA		VIII A				IB		IIB										
		57 La Lanthanum 6 K 12 K 18 GPa	58 Ce Cerium 1.7 K film	59 Pr Praseodymium	60 Nd Neodymium	61 Pm Promethium	62 Sm Samarium	63 Eu Europium film	64 Gd Gadolinium	65 Tb Terbium	66 Dy Dysprosium	67 Ho Holmium	68 Er Erbium	69 Tm Thulium	70 Yb Ytterbium	71 Lu Lutetium 0.1 K												
		89 Ac Actinium	90 Th Thorium 1.4 K	91 Pa Protactinium 1.4 K	92 U Uranium 0.7 K 2.2 K 1 GPa	93 Np Neptunium	94 Pu Plutonium	95 Am Americium 1 K	96 Cm Curium	97 Bk Berkelium	98 Cf Californium	99 Es Einsteinium	100 Fm Fermium	101 Md Mendelevium	102 No Nobelium	103 Lr Lawrencium												

Figure 4. Periodic Table of elements with critical temperature at normal pressure, and maximum critical temperature attained under certain conditions (pressure, film form or charge injected) [Yamashita].



In the **Tl-Pb-Bi** System, the mass can be held almost constant and the variation of  $T_C$  with  $e/a$  can be studied in a continuous fashion even up to **9 K**



Variation of Transition Temperature with electrons-to-atom ratio in the Tl-Pb-Bi alloy family.

*After Dynes and Rowell, Phys. Rev. B 11,1884 (1975)*

**PdH** is a very famous material for the reversal isotope effect and it has low resistivity

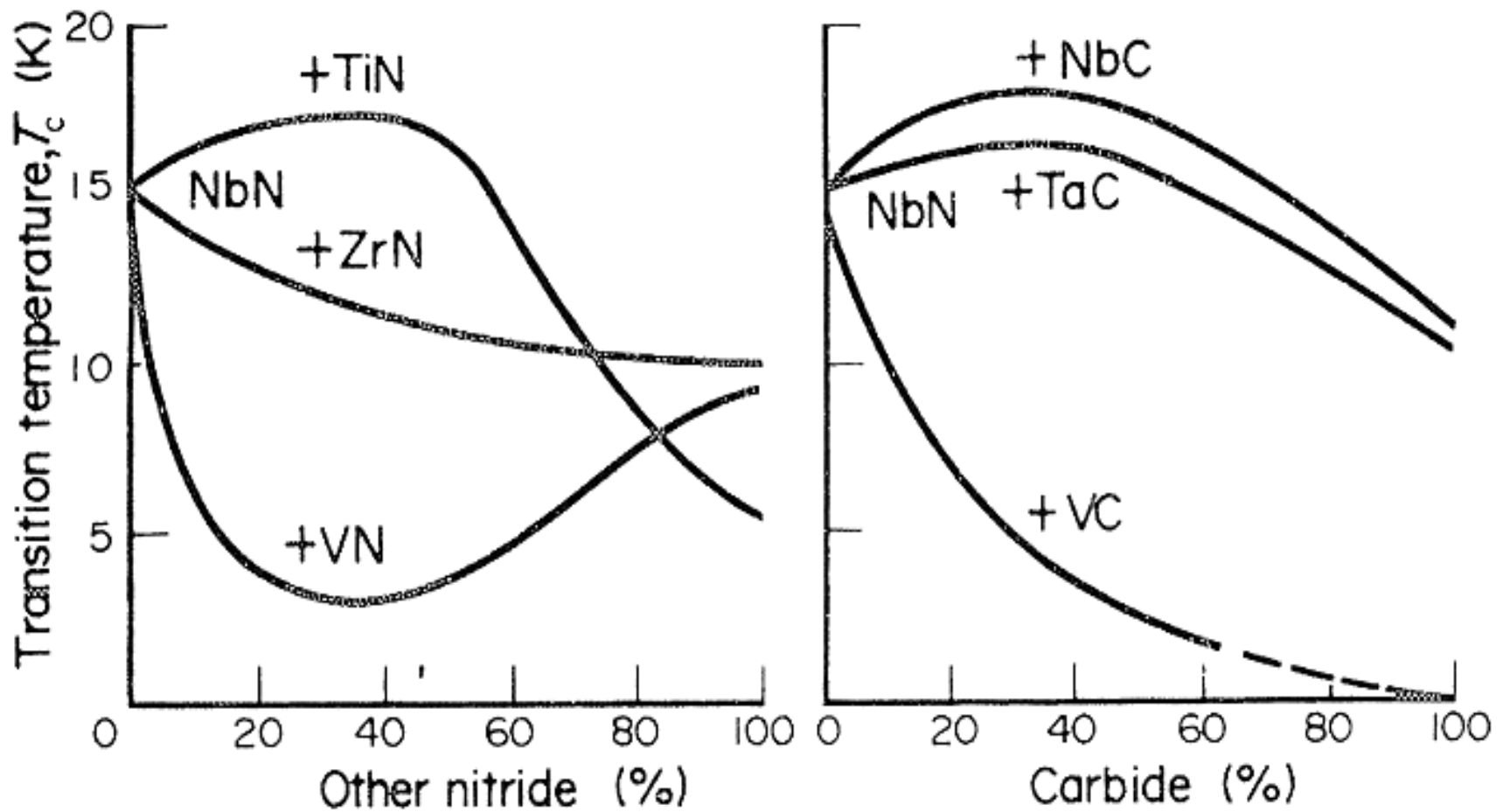
And Hydrides of Pd-Ag and Pd-Cu display Tc up to 15K!!!

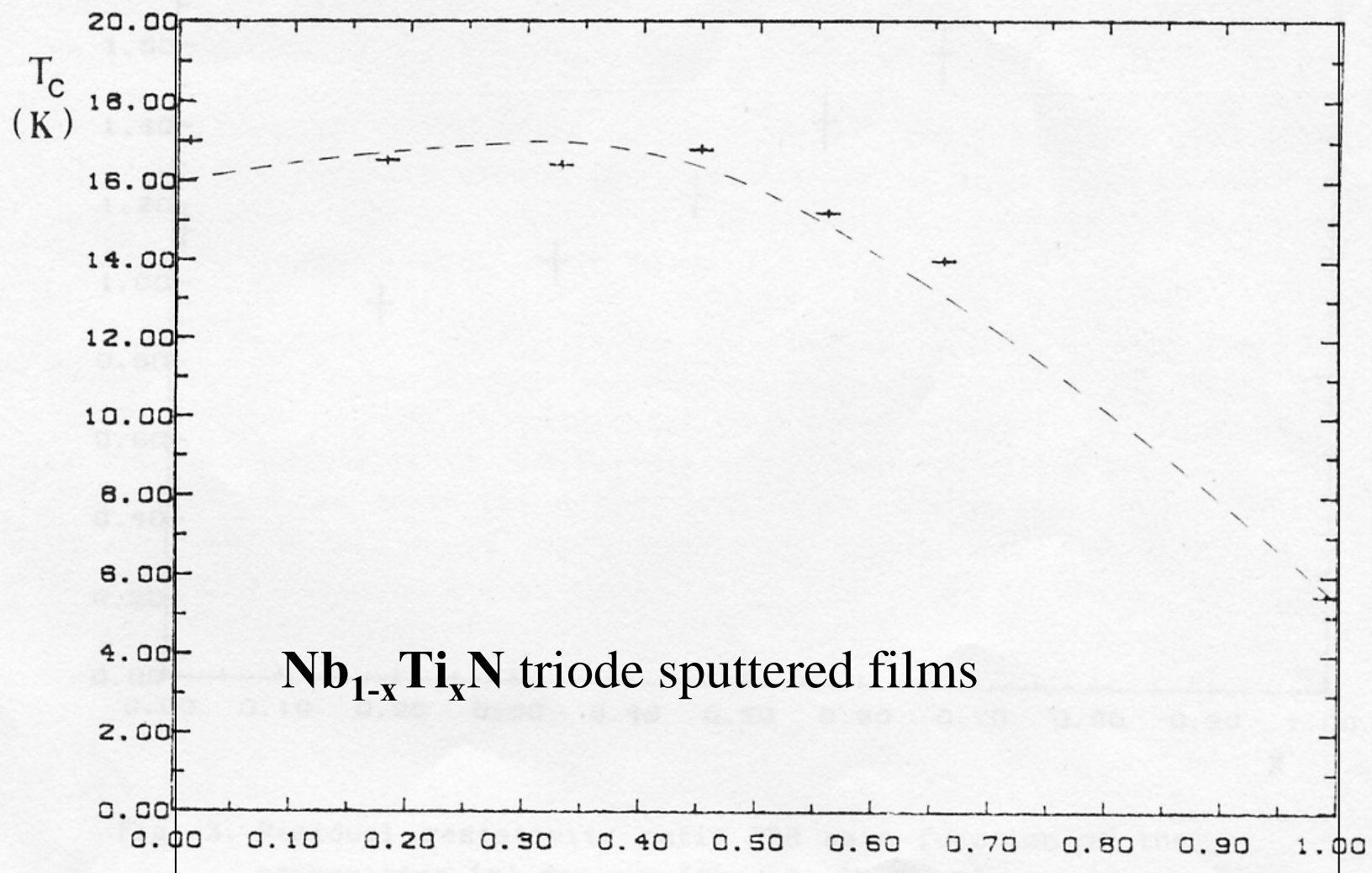
## *Critical Temperature of compounds with NaCl structure*

B \ A	Sc	Y	La	Ti	Zr	Hf	V	Nb	Ta	Cr	Mo	W	Re
B					3.4	3.1							
C	<1.38	<1.38		3.42	<0.3	<1.20	0.03 3.2*	12	10.35		14.3	10.0	3.4
N	<1.38	<1.4	1.35	5.49	10.7	8.83	8.5	17.3	6.5	<1.28	5.0	<1.38	
P			<1.68										
Sb		<1.02	<1.02										
O				2.0			<0.3	1.39					
S	<0.33	1.9	0.87		3.3								
Se	<0.33	2.5	1.02										
Te		2.05	1.48										

\*  $T_C = 3.2$  K was registered in vanadium carbide after implantation of  $C^+$  ions <sub>s</sub>

*Critical temperature vs composition  
for nitride and carbide **addition to NbN***

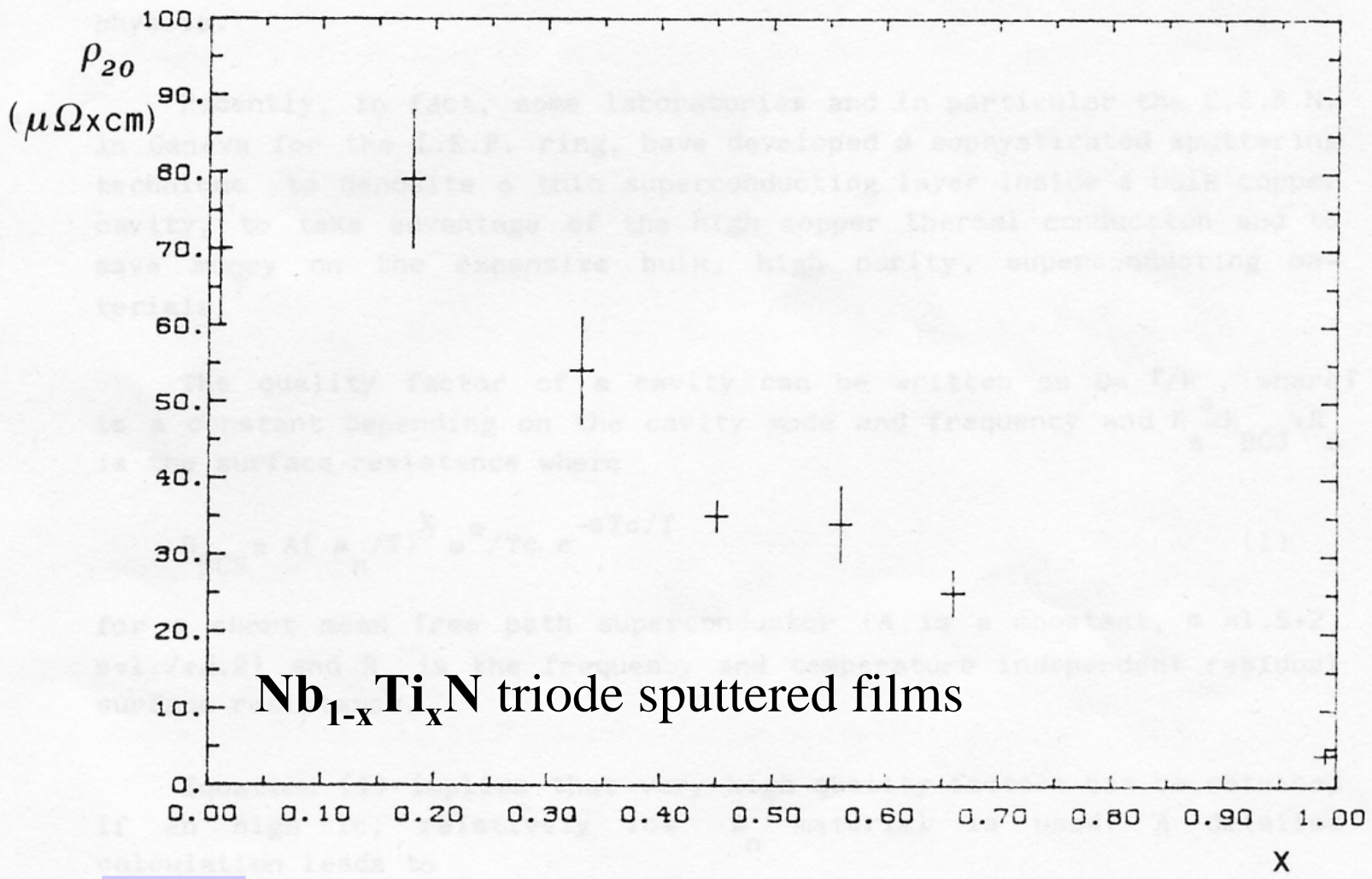




NbN

TiN

A.Nigro, G.Nobile, V.Palmieri, R.Vaglio, "PROPERTIES OF NIOBIUM-TITANIUM NITRIDE SUPERCONDUCTING THIN FILMS", Adv. Cryog. Eng. Mat., vol. 34, (1988) 813

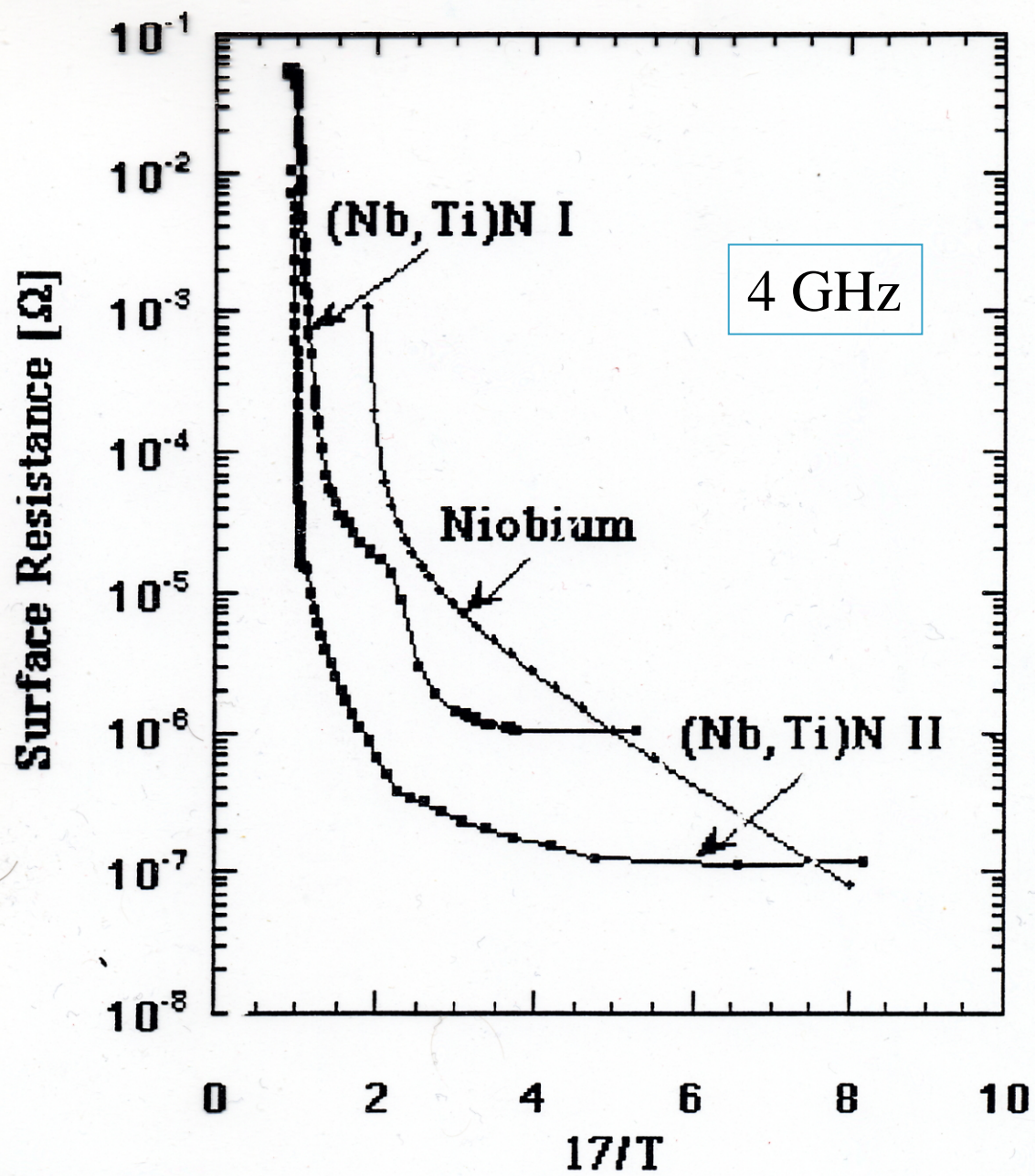


NbN

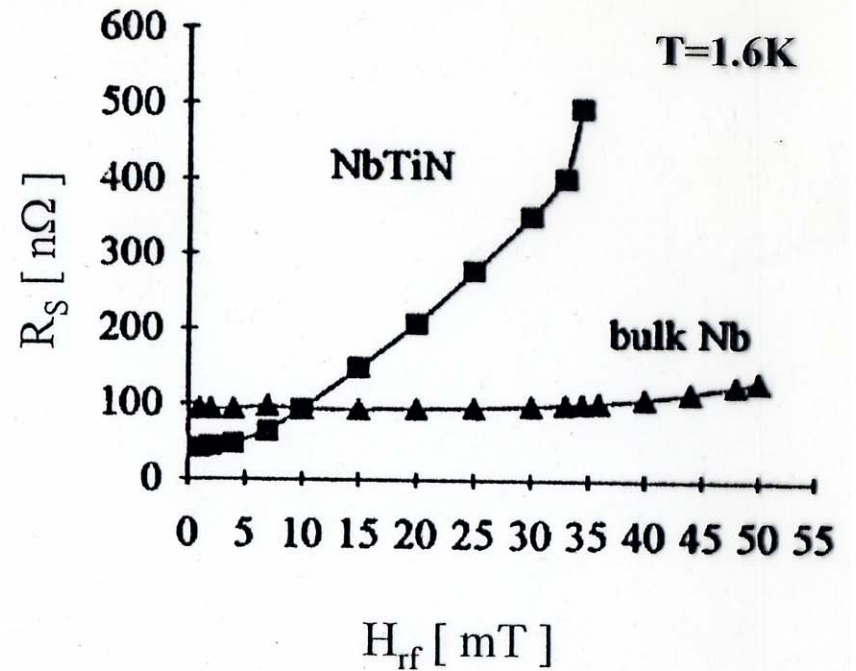
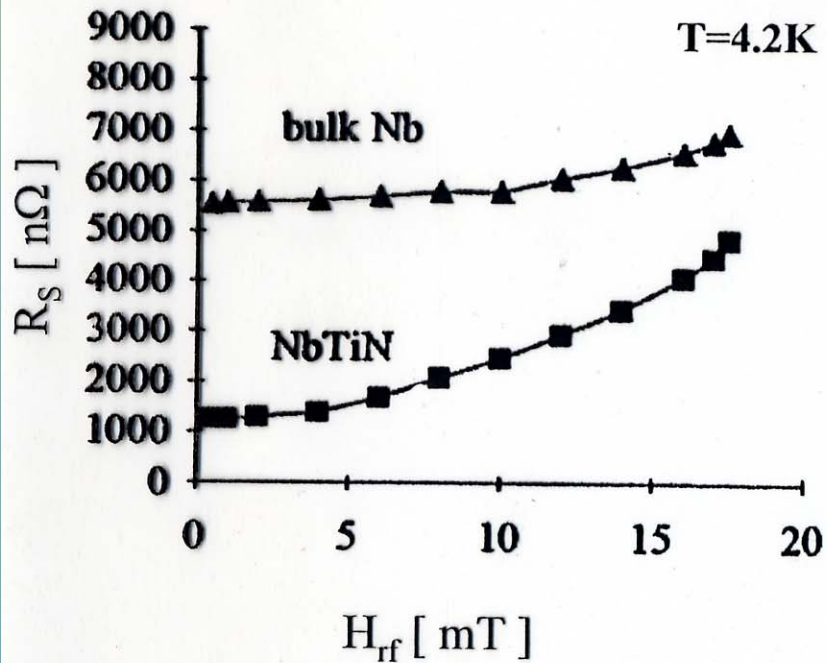
TiN

A.Nigro, G.Nobile, V.Palmieri, R.Vaglio, "PROPERTIES OF NIOBIUM-TITANIUM NITRIDE SUPERCONDUCTING THIN FILMS", Adv. Cryog. Eng. Mat., vol. 34, (1988) 813





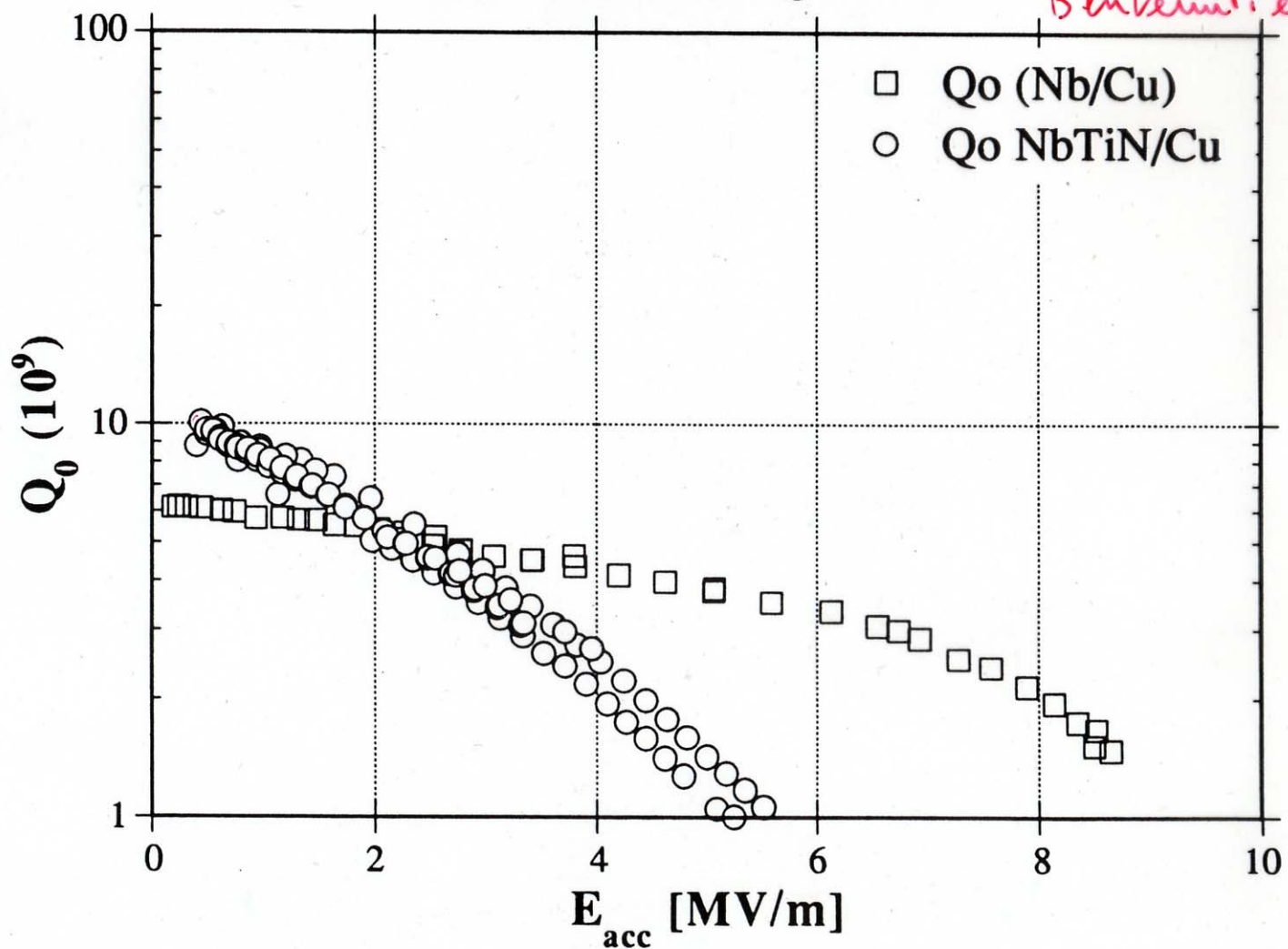
# Surface resistance of a $(\text{Nb}_{0.55}\text{Ti}_{0.45})\text{N}/\text{Cu}$ film (4 GHz)



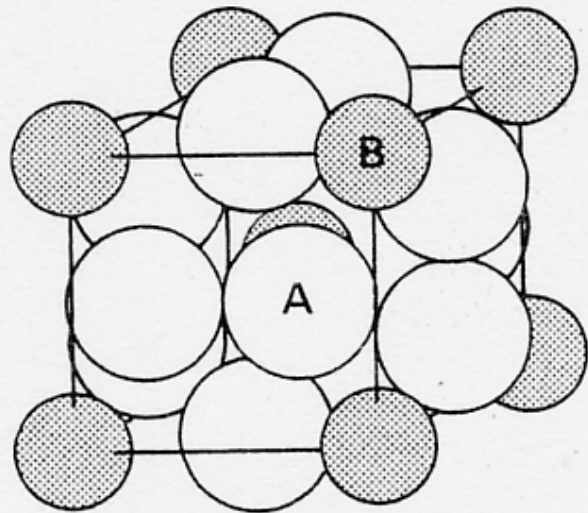
After R. Vepko et al.

Cav. 500 MHz @ 4.2 K

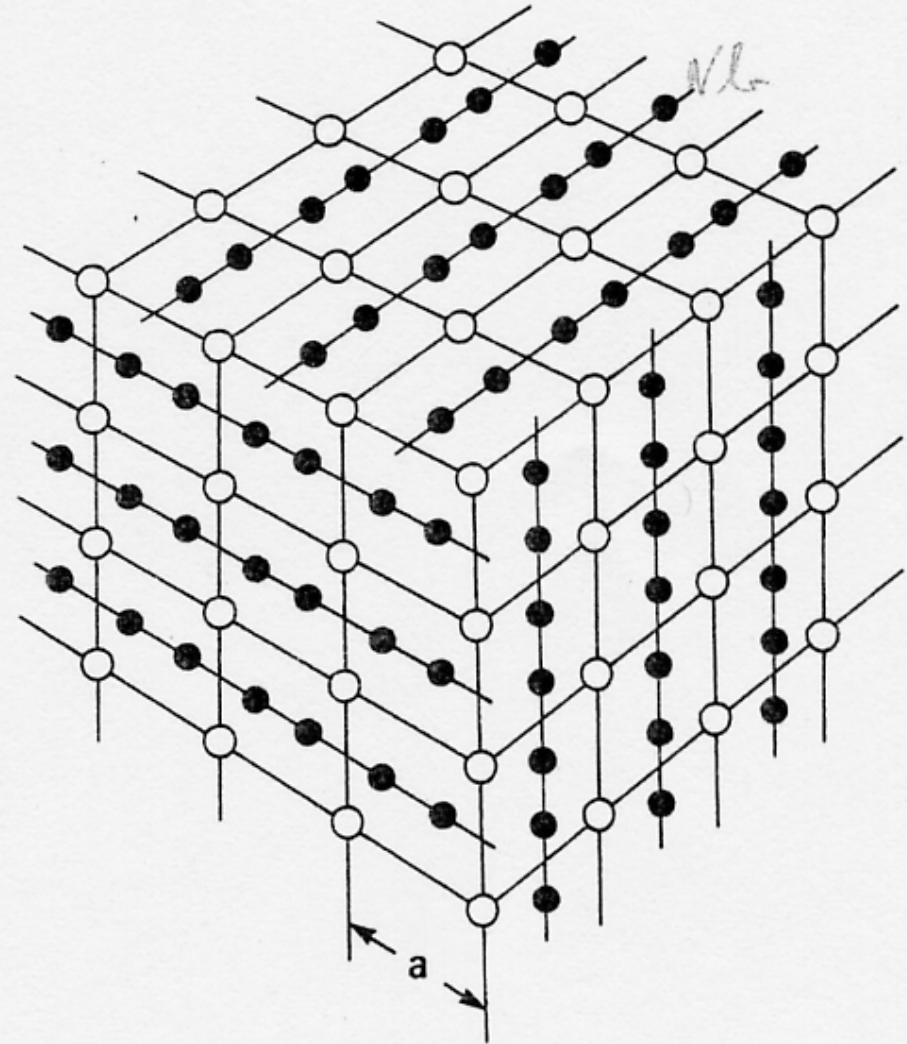
*B. M. V. et al*





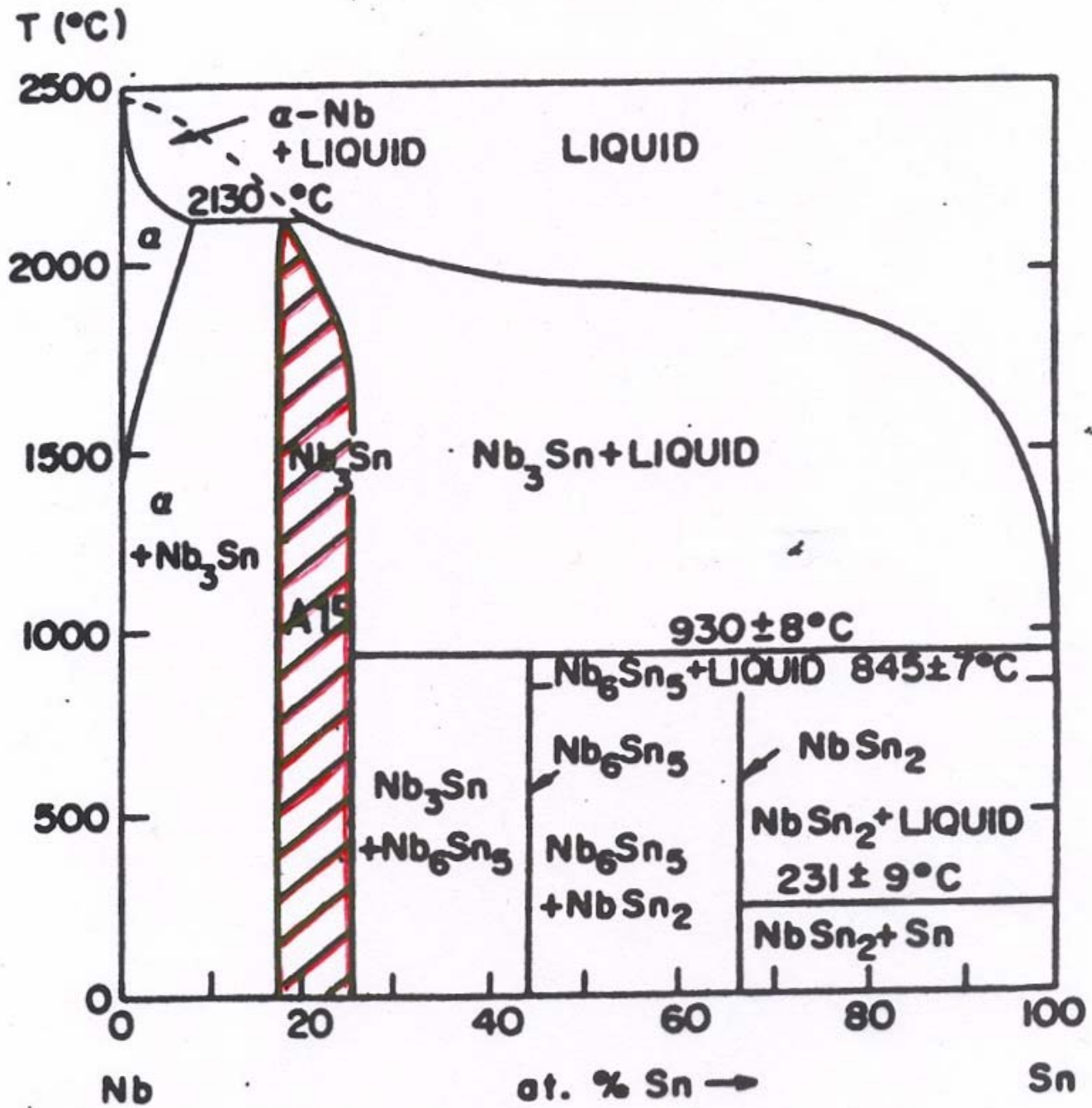


A-15 (OR  $\beta$ -W)  
 $A_3B$



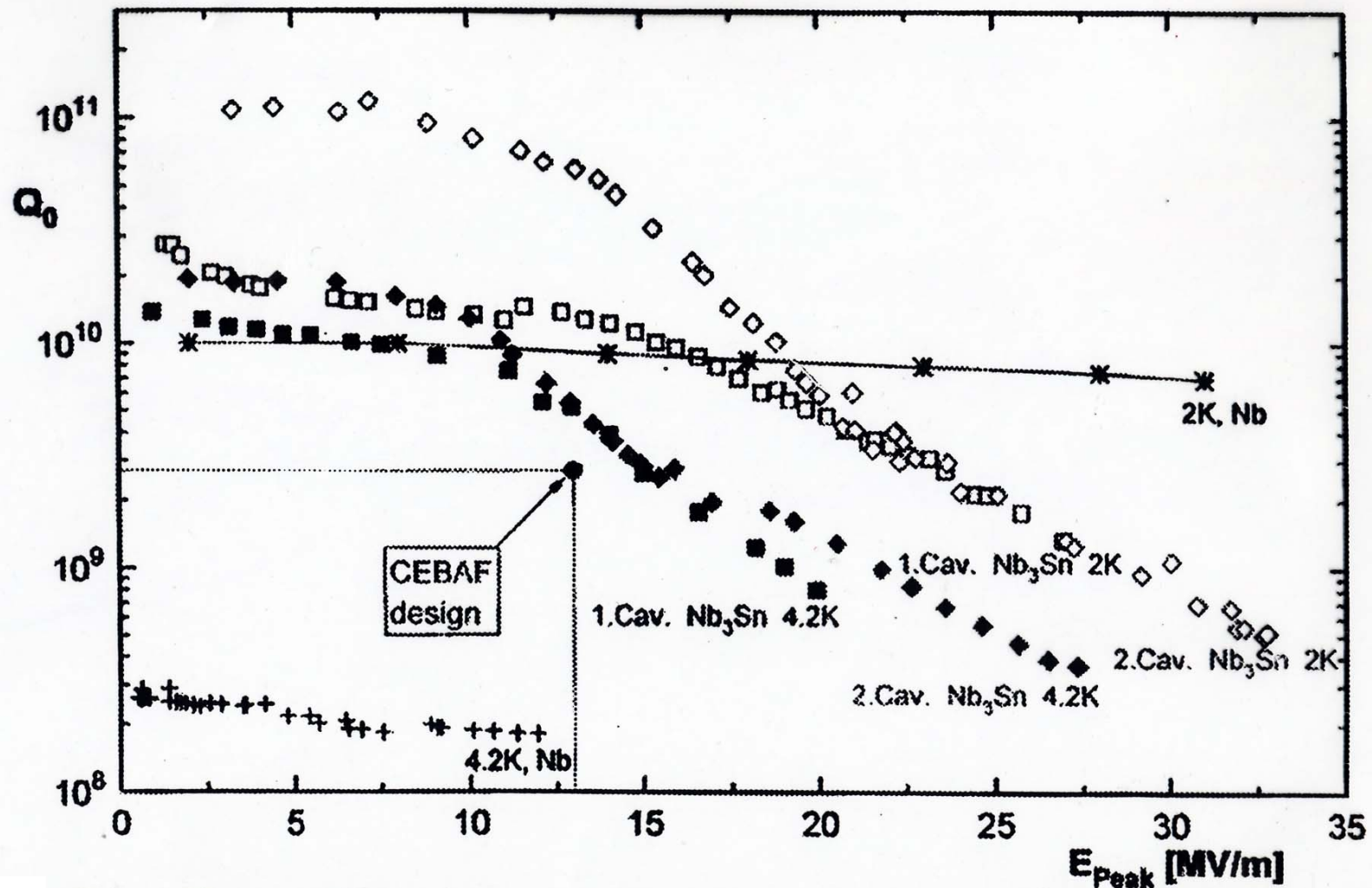
Nontransition elements	$T_c$ (K)	Transition elements	$T_c$ (K)
Ti <sub>3</sub> Sb	6.5	Ti <sub>3</sub> Ir	4.2
Zr <sub>80</sub> Sn <sub>20</sub> <sup>a</sup>	0.92	Ti <sub>3</sub> Pt	0.5
Zr-Pb	0.76	Zr <sub>3</sub> Au	0.9
Zr <sub>~3</sub> Bi <sup>b</sup>	3.4	V <sub>29</sub> Re <sub>71</sub>	8.4
V-Al <sup>c</sup>	14	V <sub>50</sub> Os <sub>50</sub>	5.7
V <sub>3</sub> Ga	15.9	V <sub>65</sub> Rh <sub>35</sub>	≈ 1
V <sub>3</sub> Si	17.0	V <sub>63</sub> Ir <sub>37</sub>	1.7
V <sub>~3</sub> Ge	6	V <sub>~3</sub> Pd	0.08
V <sub>~3</sub> Ge <sup>c</sup>	11	V <sub>3</sub> Pt	3.7
V <sub>~79</sub> Sn <sub>~21</sub>	3.8	V <sub>76</sub> Au <sub>24</sub>	3
V <sub>77</sub> As <sub>23</sub>	0.2	Nb <sub>75</sub> Os <sub>25</sub>	1.0
V <sub>76</sub> Sb <sub>24</sub>	0.8	Nb <sub>75</sub> Rh <sub>25</sub>	2.6
Nb <sub>3</sub> Al	19.1	Nb <sub>72</sub> Ir <sub>28</sub>	3.2
Nb <sub>3</sub> Ga	20.7	Nb <sub>3</sub> Pt	11
Nb <sub>~3</sub> In <sup>b</sup>	9.2	Nb <sub>~3</sub> Au	11.5
Nb <sub>82</sub> Si <sub>18</sub> <sup>a</sup>	4.4	Ta <sub>85</sub> Pt <sub>15</sub>	0.4
Nb-Si <sup>c</sup>	11-17	Ta <sub>~80</sub> Au <sub>20</sub>	0.55
Nb-Ge <sup>a</sup>	17	Cr <sub>72</sub> Ru <sub>28</sub>	3.4
Nb-Ge <sup>c</sup>	23	Cr <sub>73</sub> Os <sub>27</sub>	4.7
Nb <sub>3</sub> Sn	18	Cr <sub>78</sub> Rh <sub>22</sub>	0.07
Nb-Sb	2	Cr <sub>82</sub> Ir <sub>18</sub>	0.75
Nb <sub>~3</sub> Bi <sup>b</sup>	3	Mo <sub>40</sub> Tc <sub>60</sub>	13.4
Ta <sub>~3</sub> Ge <sup>c</sup>	8	Mo <sub>~65</sub> Re <sub>~35</sub> <sup>c</sup>	≈ 15
Ta <sub>~3</sub> Sn	8.3	Mo <sub>75</sub> Os <sub>25</sub>	13.1
Ta <sub>~3</sub> Sb	0.7	Mo <sub>78</sub> Ir <sub>22</sub>	8.5
Mo <sub>3</sub> Al	0.58	Mo <sub>82</sub> Pt <sub>18</sub>	4.6
Mo <sub>3</sub> Ga	0.76	W <sub>~60</sub> Re <sub>~40</sub> <sup>c</sup>	11
Mo <sub>77</sub> Si <sub>23</sub>	1.7		
Mo <sub>77</sub> Ge <sub>23</sub>	1.8		

a Rapid quenching b High-pressure synthesis c Film deposition techniques

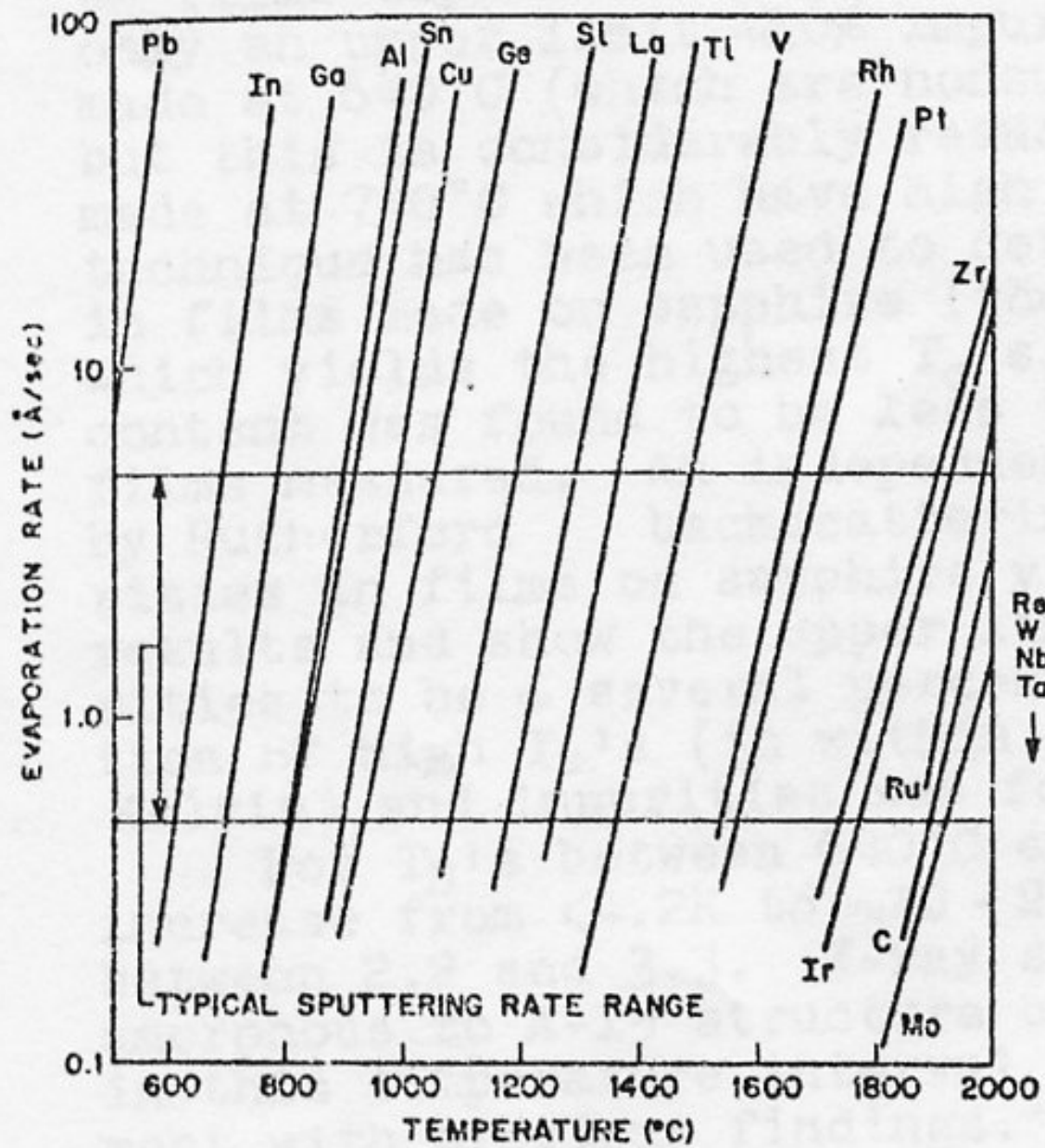




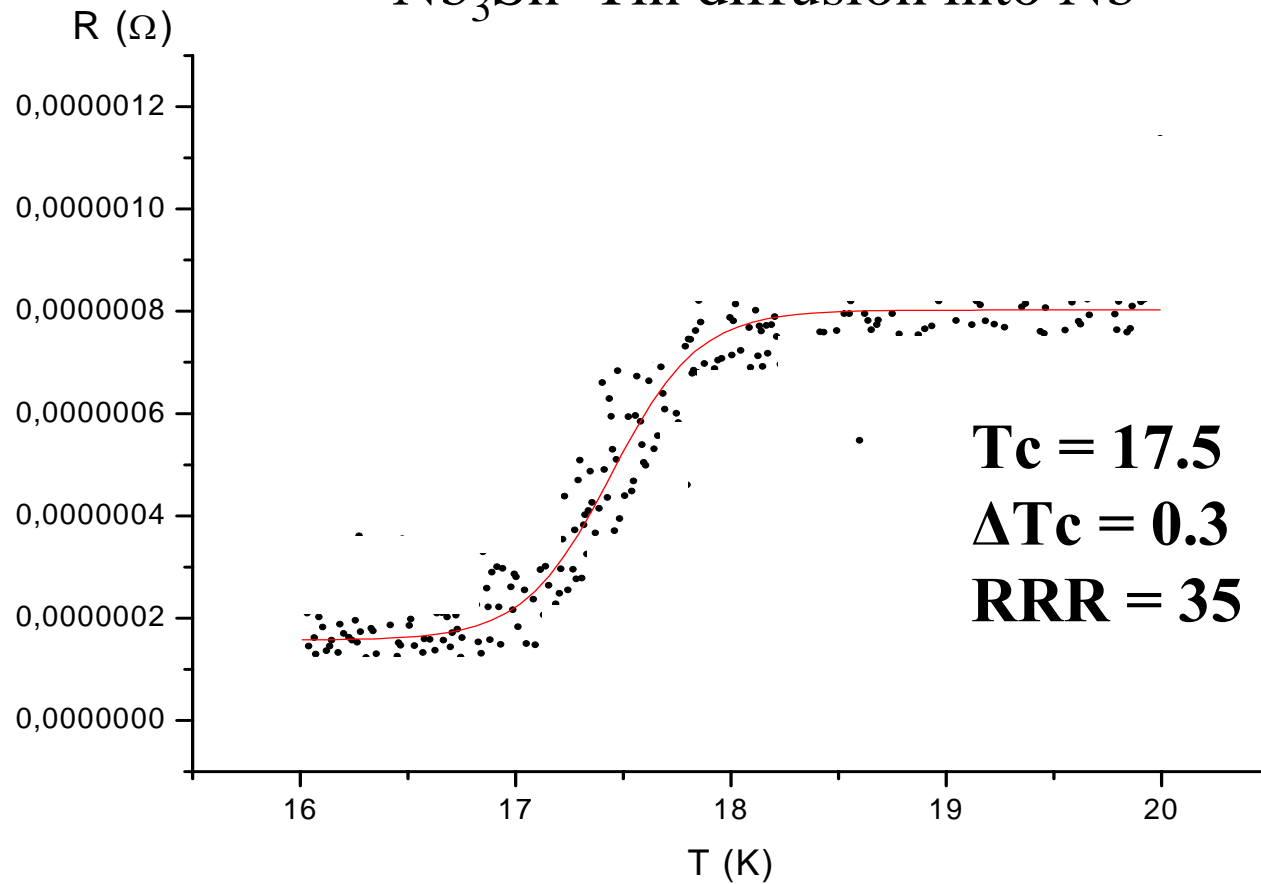
# Nb<sub>3</sub>Sn 1.5GHz cavity made at Wuppertal by Sn vapour phase diffusion



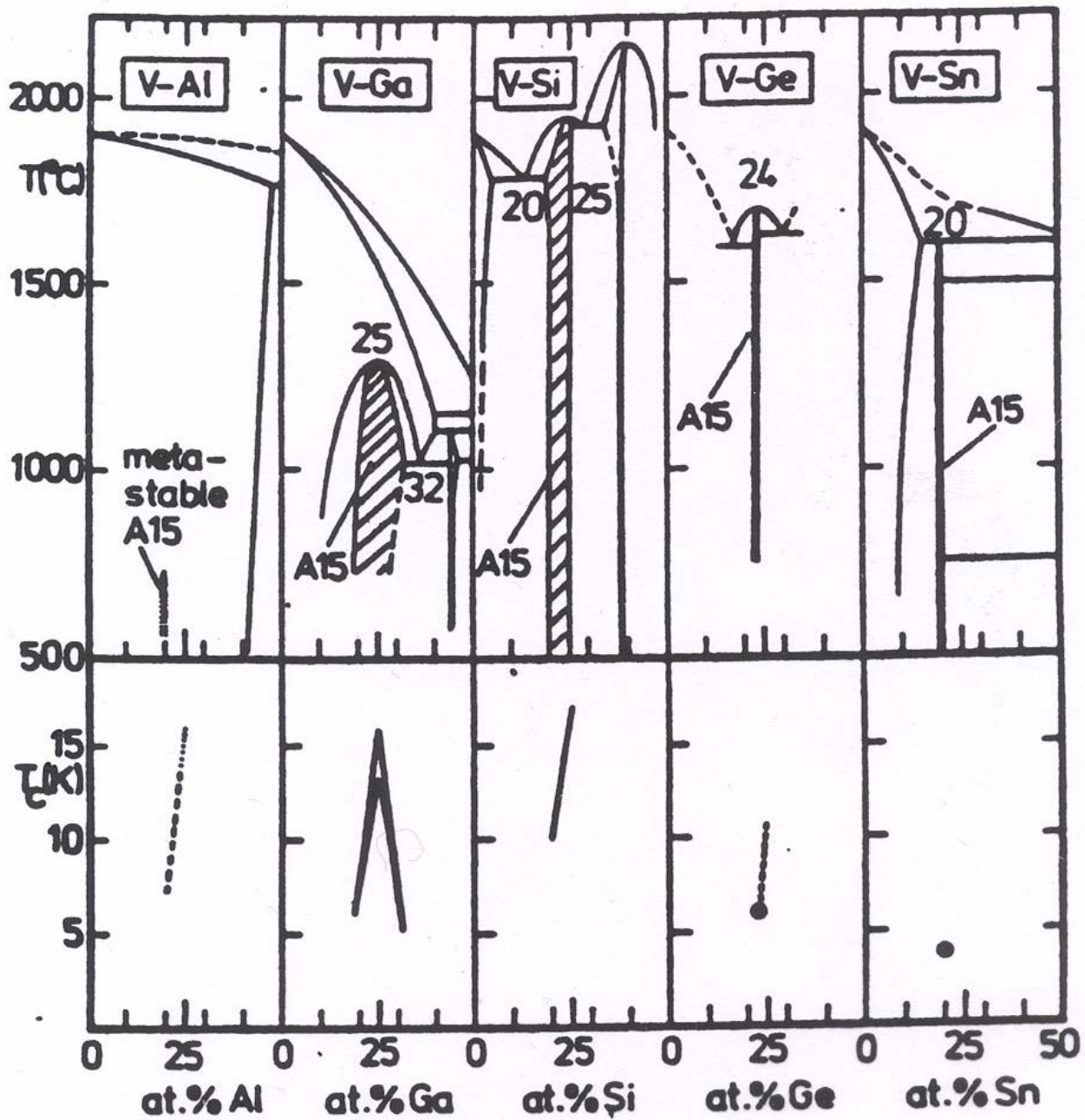
Q vs.  $E_{peak}$  of the first two Nb<sub>3</sub>Sn-coated 1.5 GHz single-cell cavities in comparison to pure Nb at 4.2 K and 2 K from CEBAF.



## Nb<sub>3</sub>Sn Tin diffusion into Nb

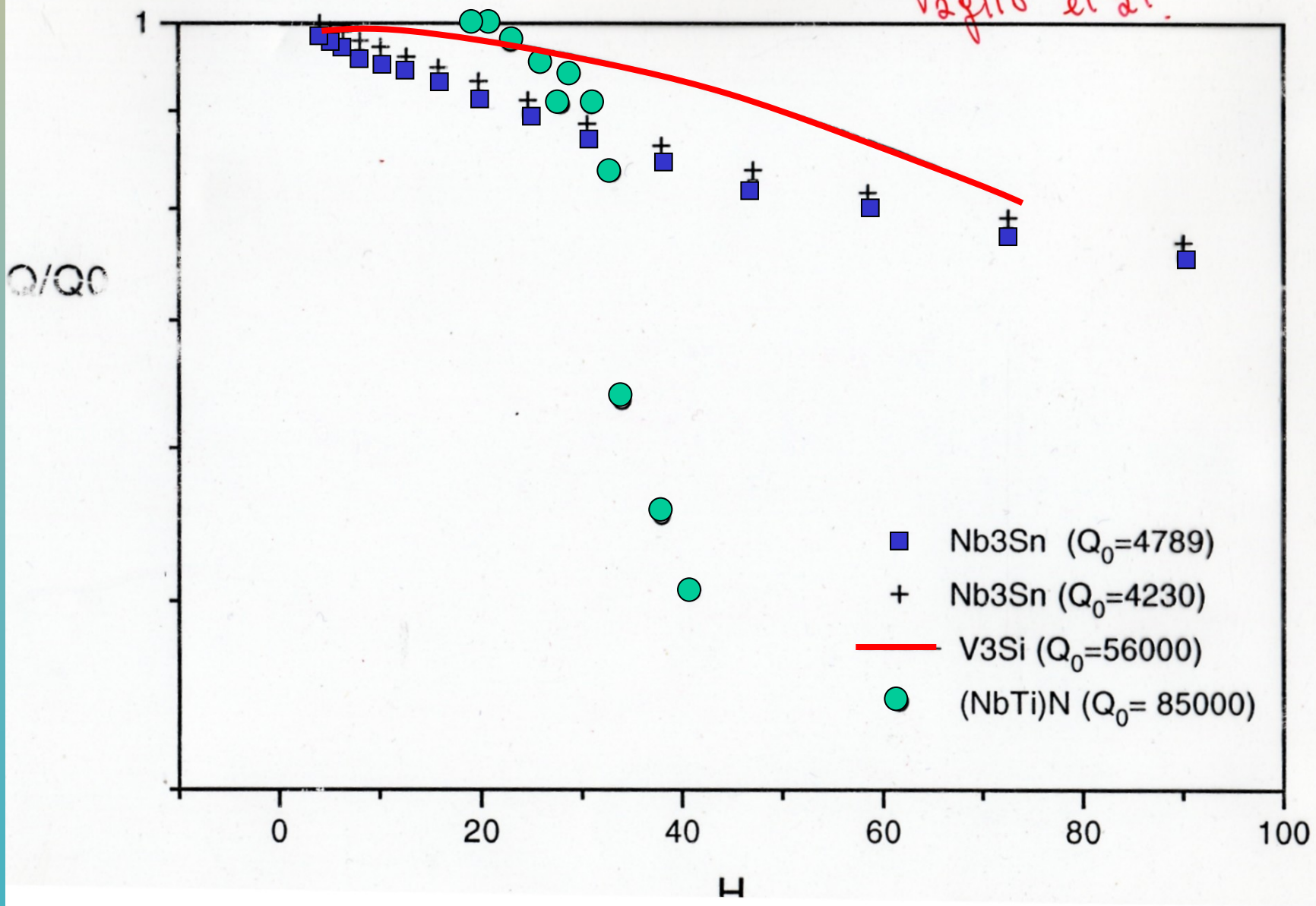


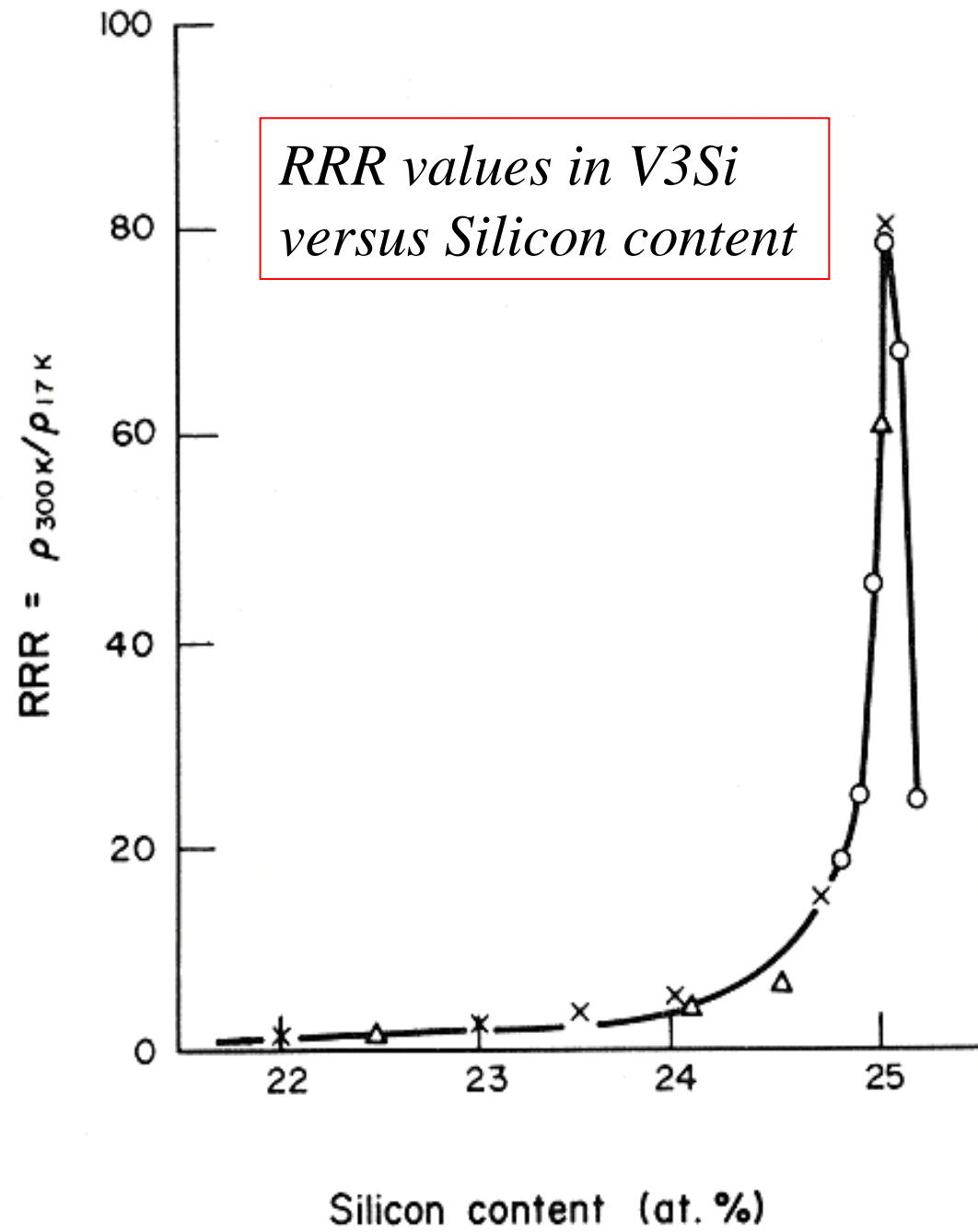
Silvia Deambrosis, Thesis 2004,  
Material Science Dept, Padua University





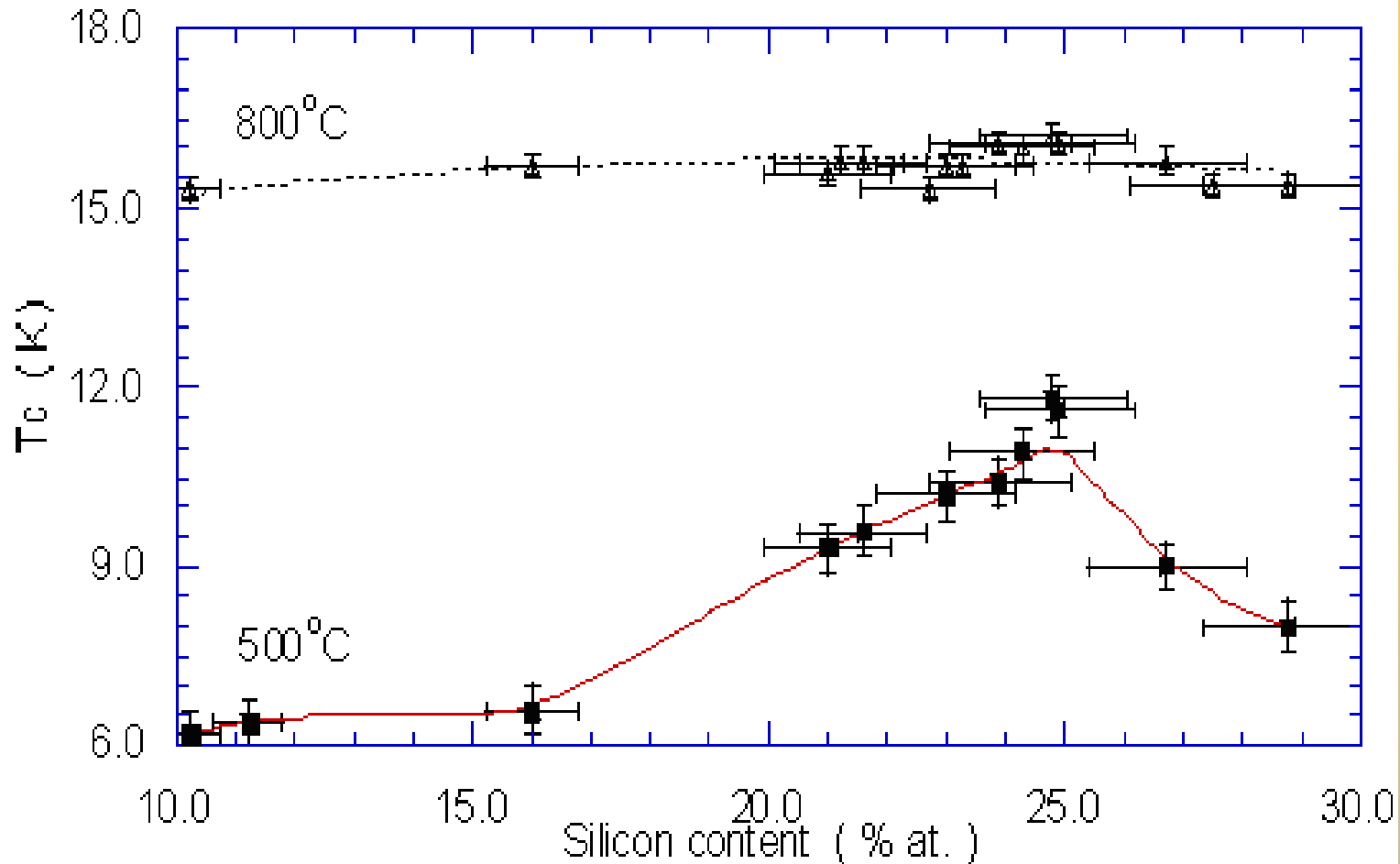
Vaglio et al.







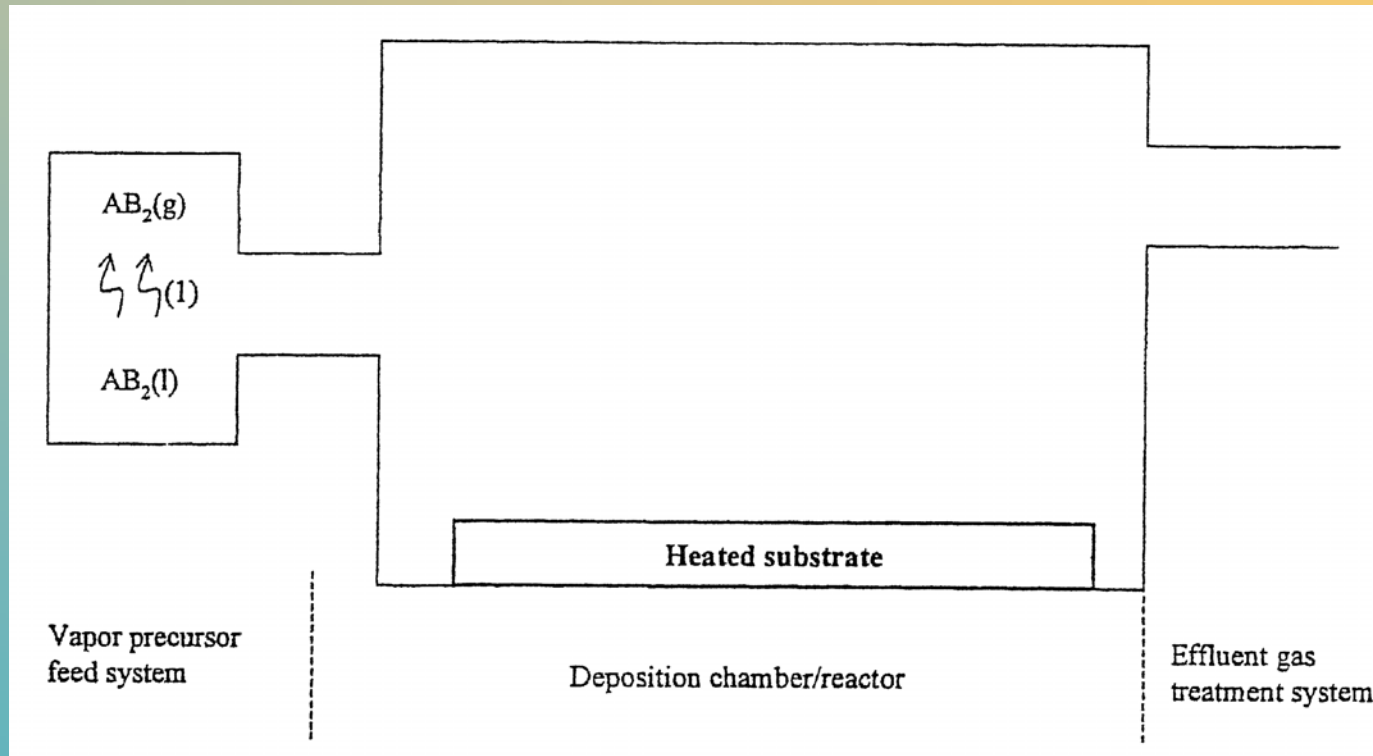
*T<sub>c</sub> vs Si content for sputtered films before and after in situ post-annealing in SiH<sub>4</sub> atmosphere*



Y. Zhang, V. Palmieri, W. Venturini, F. Stivanello, R. Preciso, LNL-INFN (REP) 157/2000

# MOCVD of Nb<sub>3</sub>Sn:

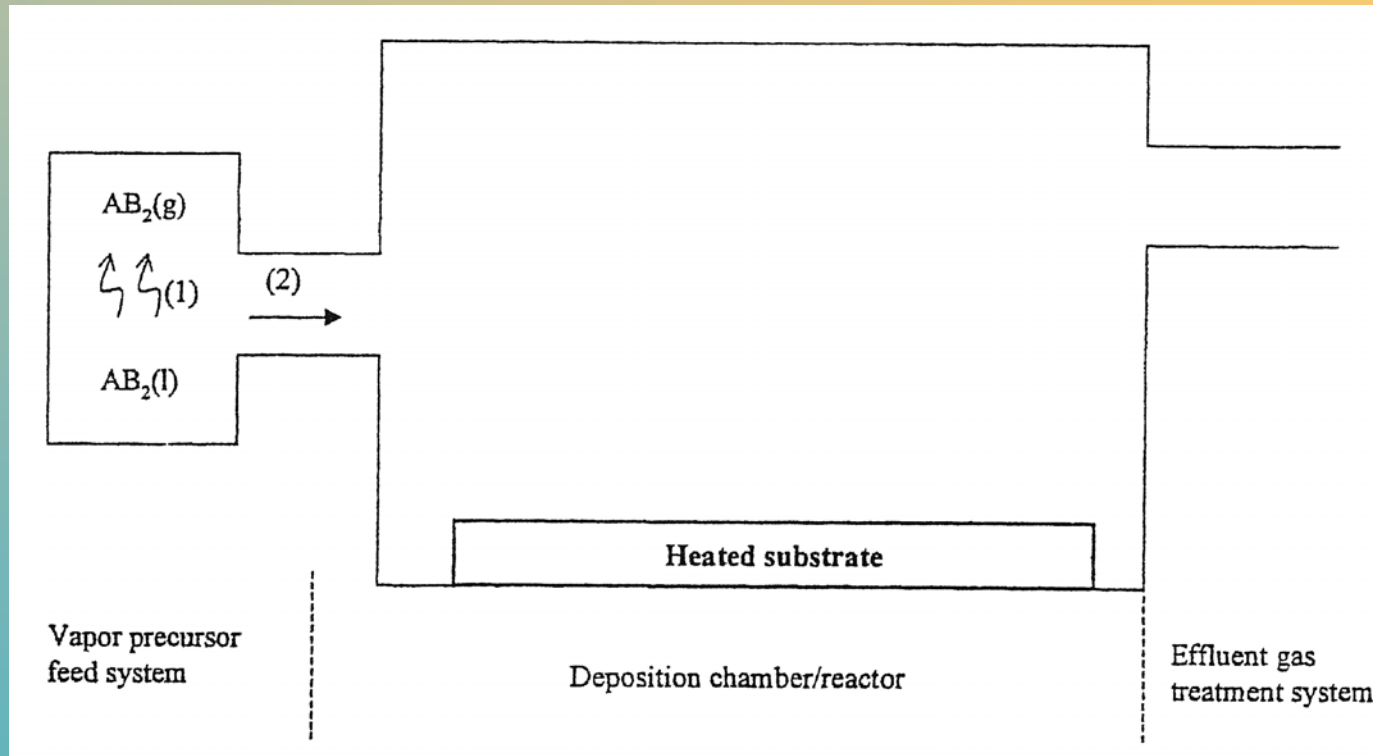
Francesco Todescato, Thesis 2004,  
Material Science Dept, Padua University



F. Todescato, E. tondello, G. Rossetto, P. Zanella and V. Palmieri,  
material still to be published

# MOCVD of Nb<sub>3</sub>Sn:

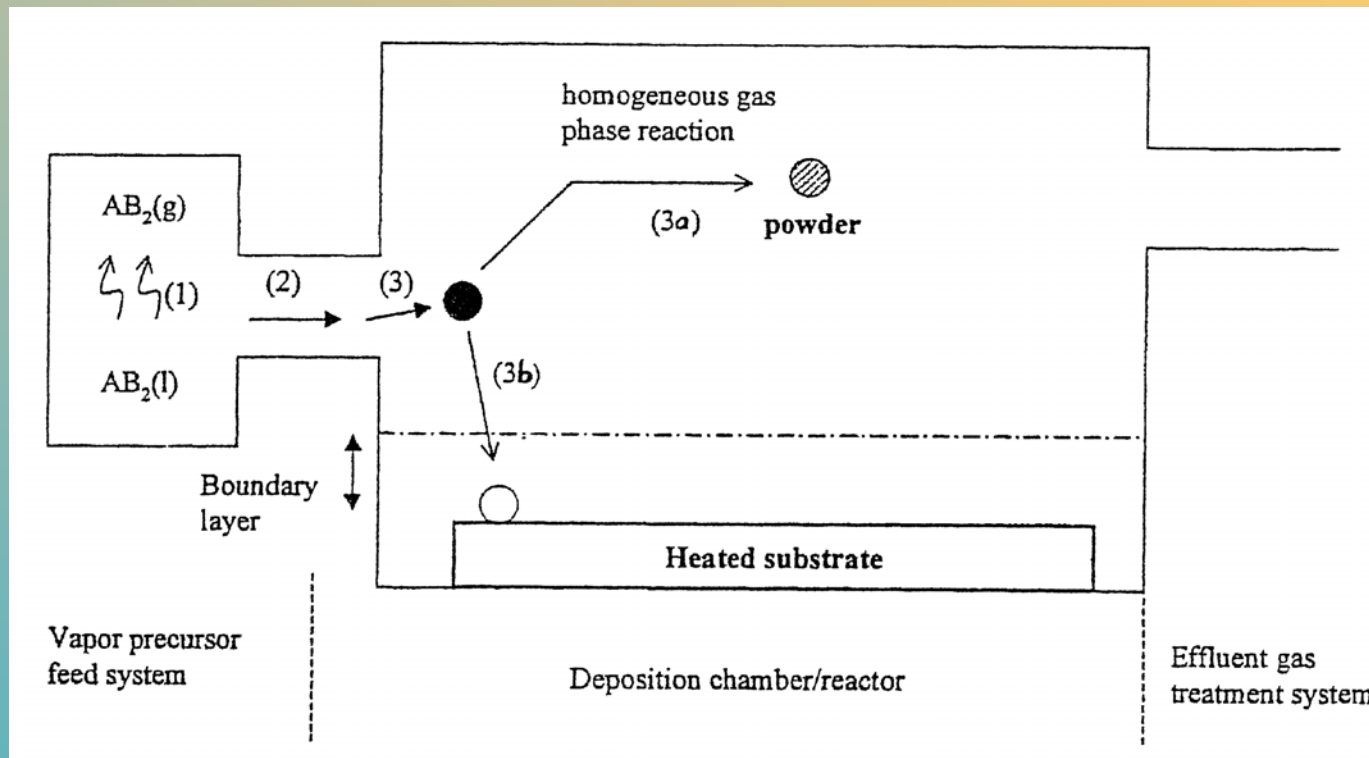
Francesco Todescato, Thesis 2004,  
Material Science Dept, Padua University



F. Todescato, E. tondello, G. Rossetto, P. Zanella and V. Palmieri,  
material still to be published

# MOCVD of Nb<sub>3</sub>Sn:

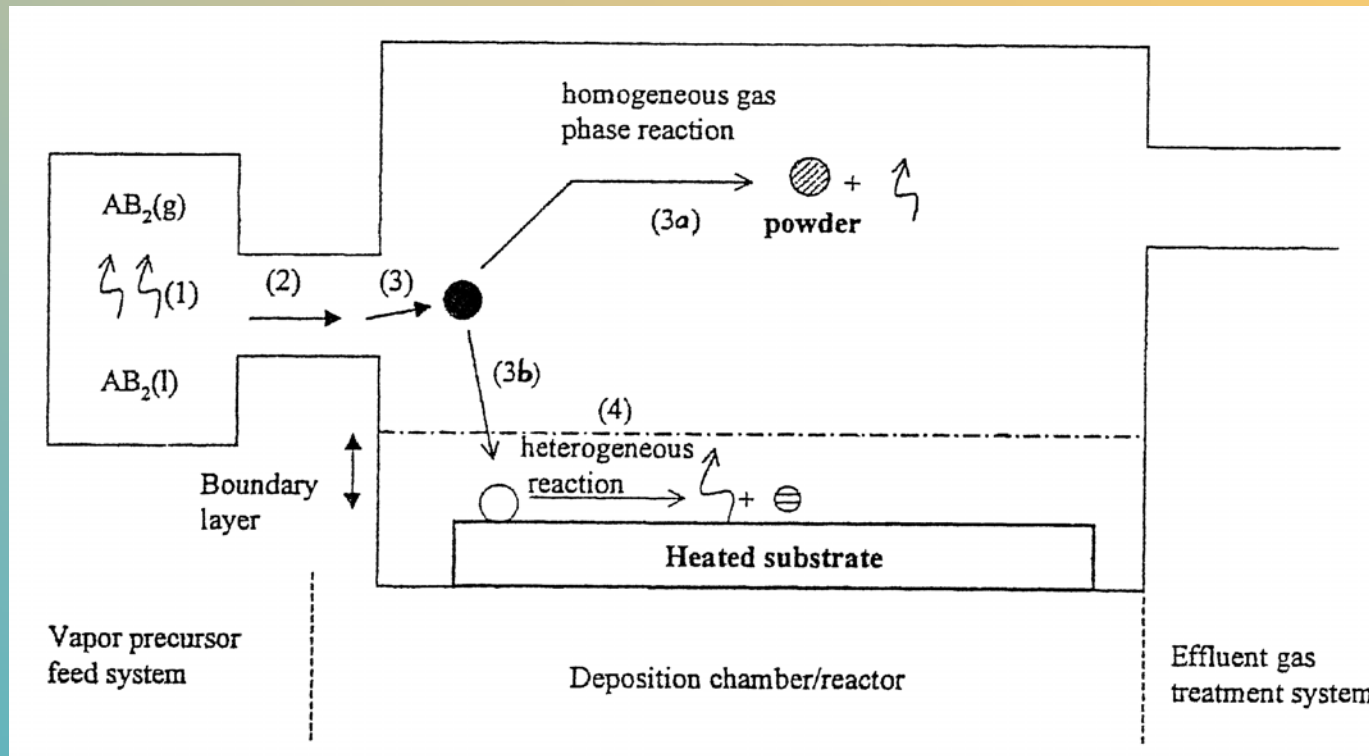
Francesco Todescato, Thesis 2004,  
Material Science Dept, Padua University



F. Todescato, E. tondello, G. Rossetto, P. Zanella and V. Palmieri,  
material still to be published

# MOCVD of Nb<sub>3</sub>Sn:

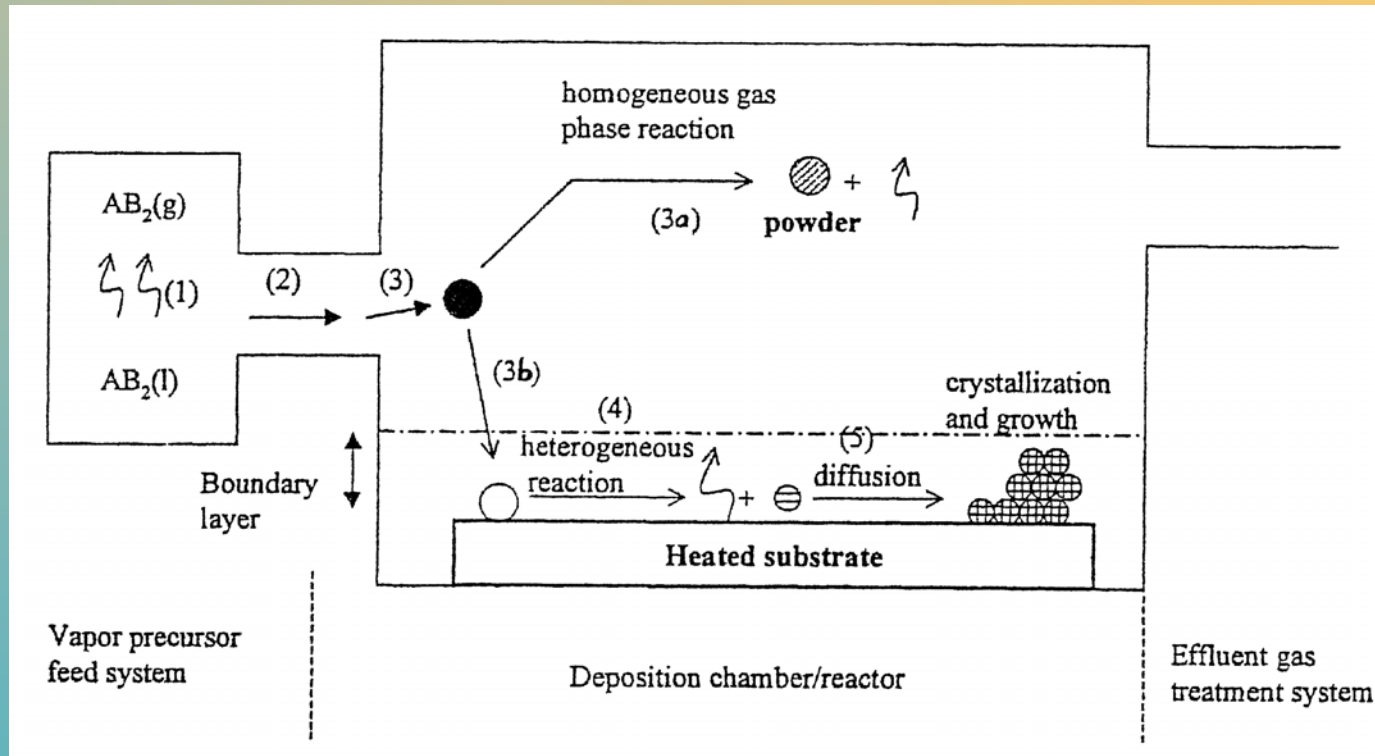
Francesco Todescato, Thesis 2004,  
Material Science Dept, Padua University



F. Todescato, E. tondello, G. Rossetto, P. Zanella and V. Palmieri,  
material still to be published

# MOCVD of Nb<sub>3</sub>Sn:

Francesco Todescato, Thesis 2004,  
Material Science Dept, Padua University

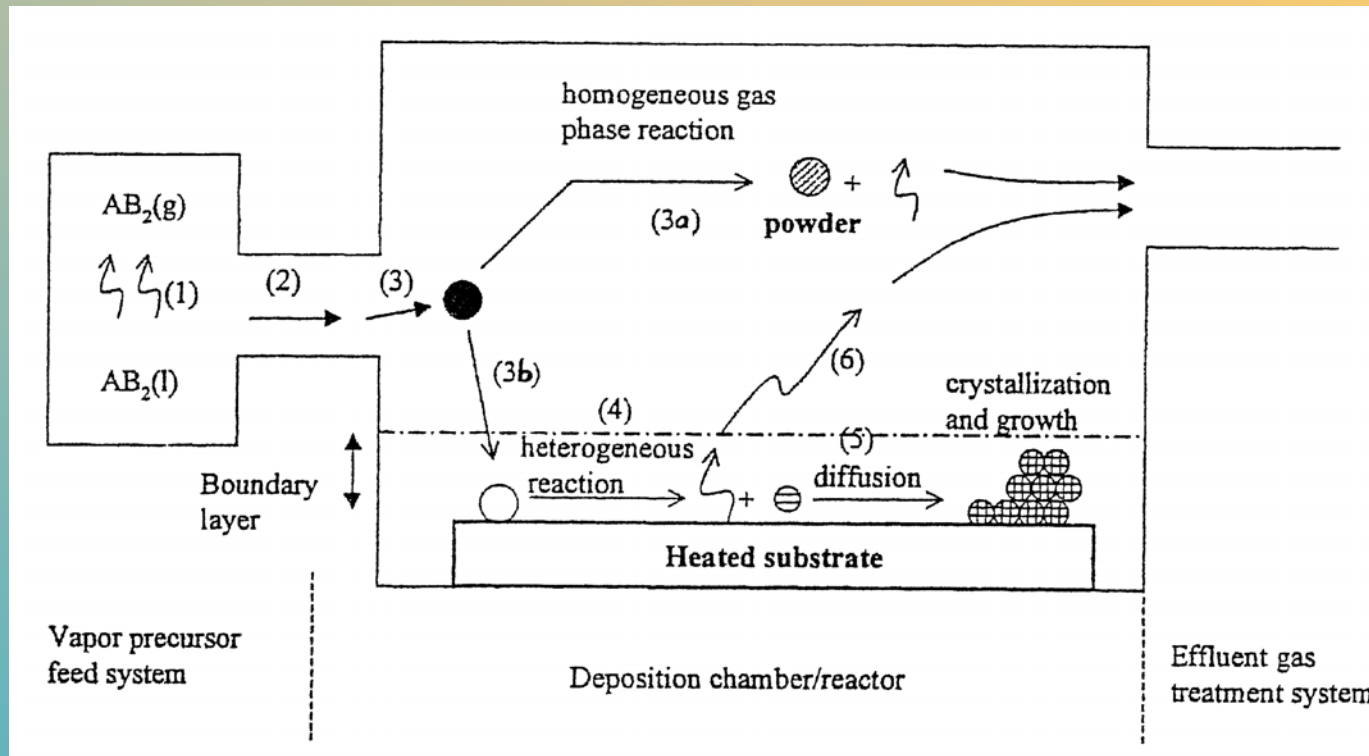


F. Todescato, E. tondello, G. Rossetto, P. Zanella and V. Palmieri,  
material still to be published



# MOCVD of Nb<sub>3</sub>Sn:

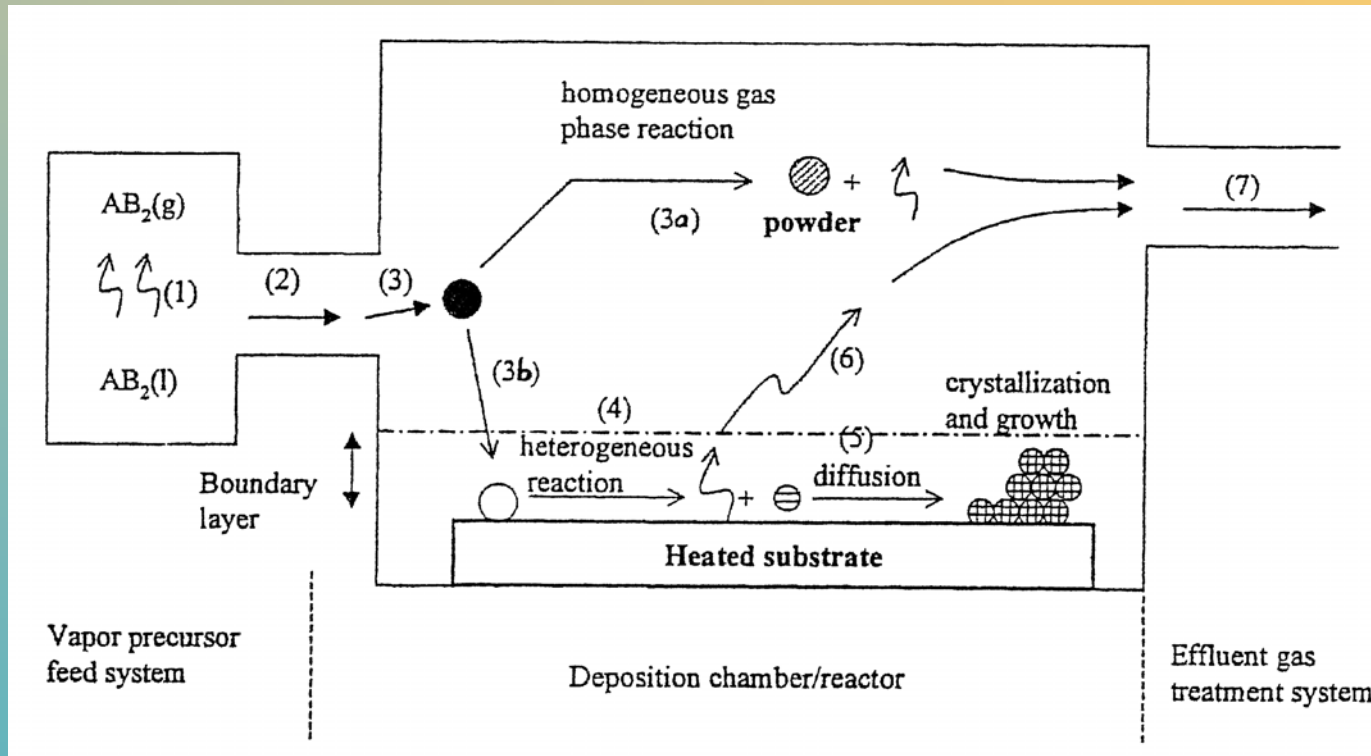
Francesco Todescato, Thesis 2004,  
Material Science Dept, Padua University



F. Todescato, E. tondello, G. Rossetto, P. Zanella and V. Palmieri,  
material still to be published

# MOCVD of Nb<sub>3</sub>Sn:

Francesco Todescato, Thesis 2004,  
Material Science Dept, Padua University



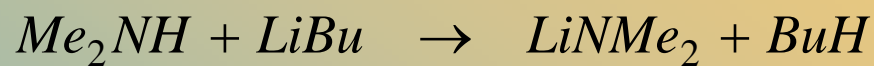
For Nb: several precursors i.e. Niobium pentakis(dimethylamide)  
For Sn: Bu<sub>3</sub>SnH

F. Todescato, E. Tondello, G. Rossetto, P. Zanella and V. Palmieri,  
material still to be published

## Synthesis of Niobium Pentakis(dimethylamide)

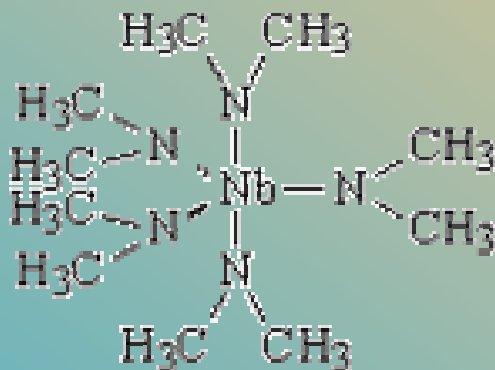
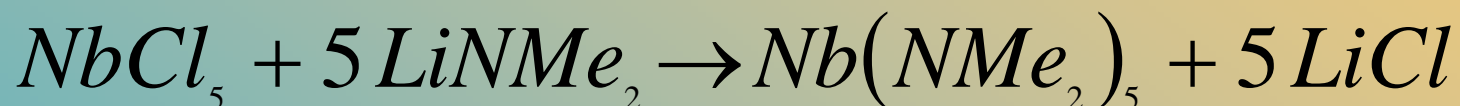
The reaction happens in two different steps:

First the  $\text{Me}_2\text{NH}$  50 mL is bubbled for around 90 minutes in LiBu:

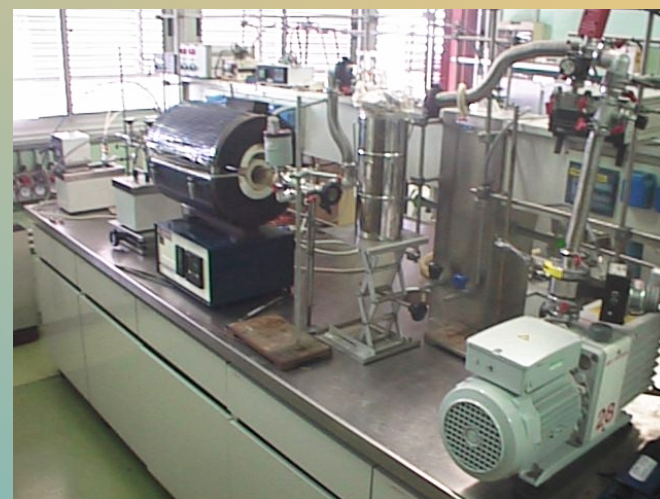


Then the butane is evaporated and the product obtained is suspended in pentane and treated by  $\text{NbCl}_5$

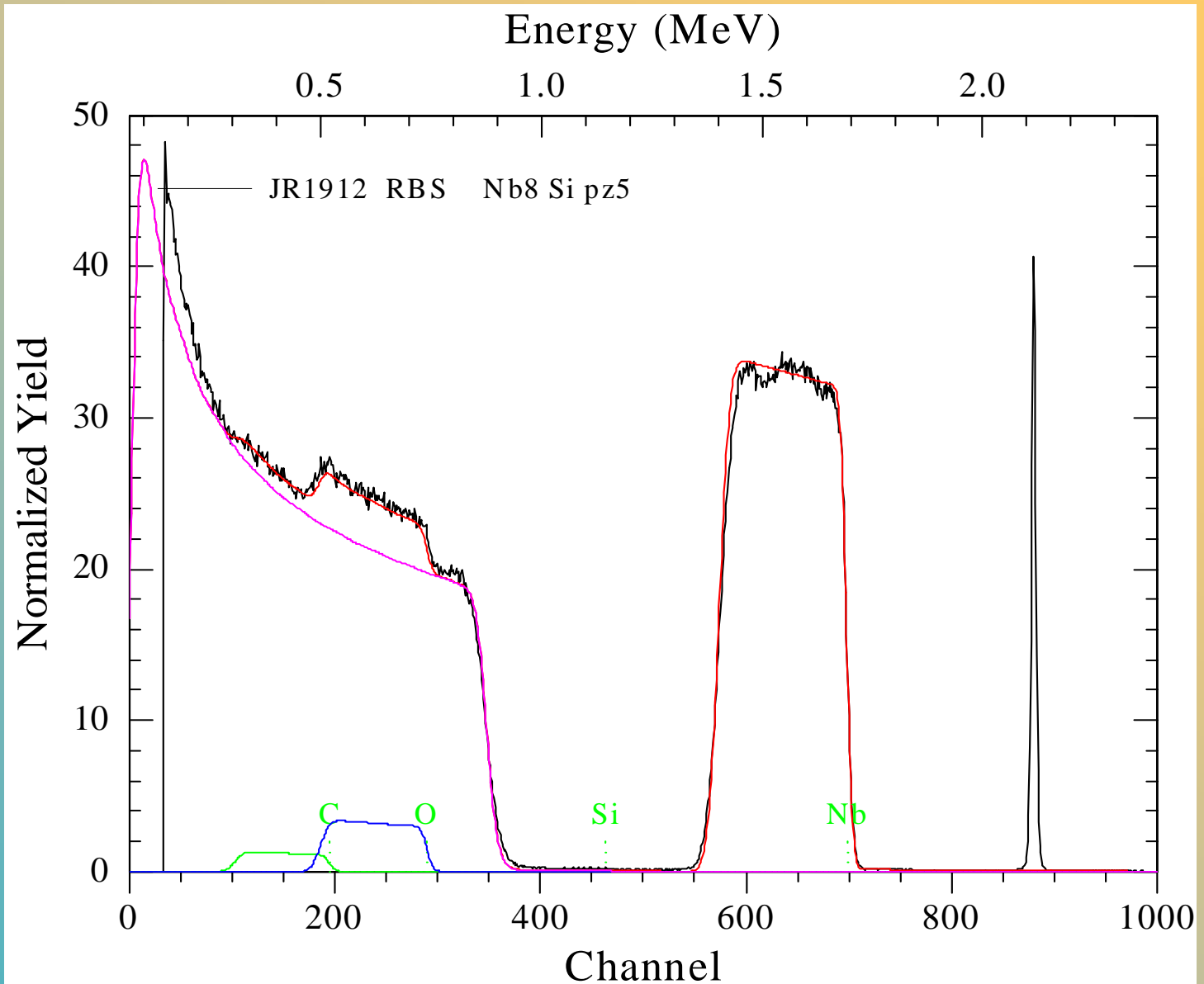
pentane



The Ammide is a brownish powder that sublimes at 130°C



# RBS del deposito 1 da $\text{CpNbMe}_4$



Rapporti relativi:

Nb = 1,00

O = 2,38

C = 1,58

A possible source of oxygen contamination



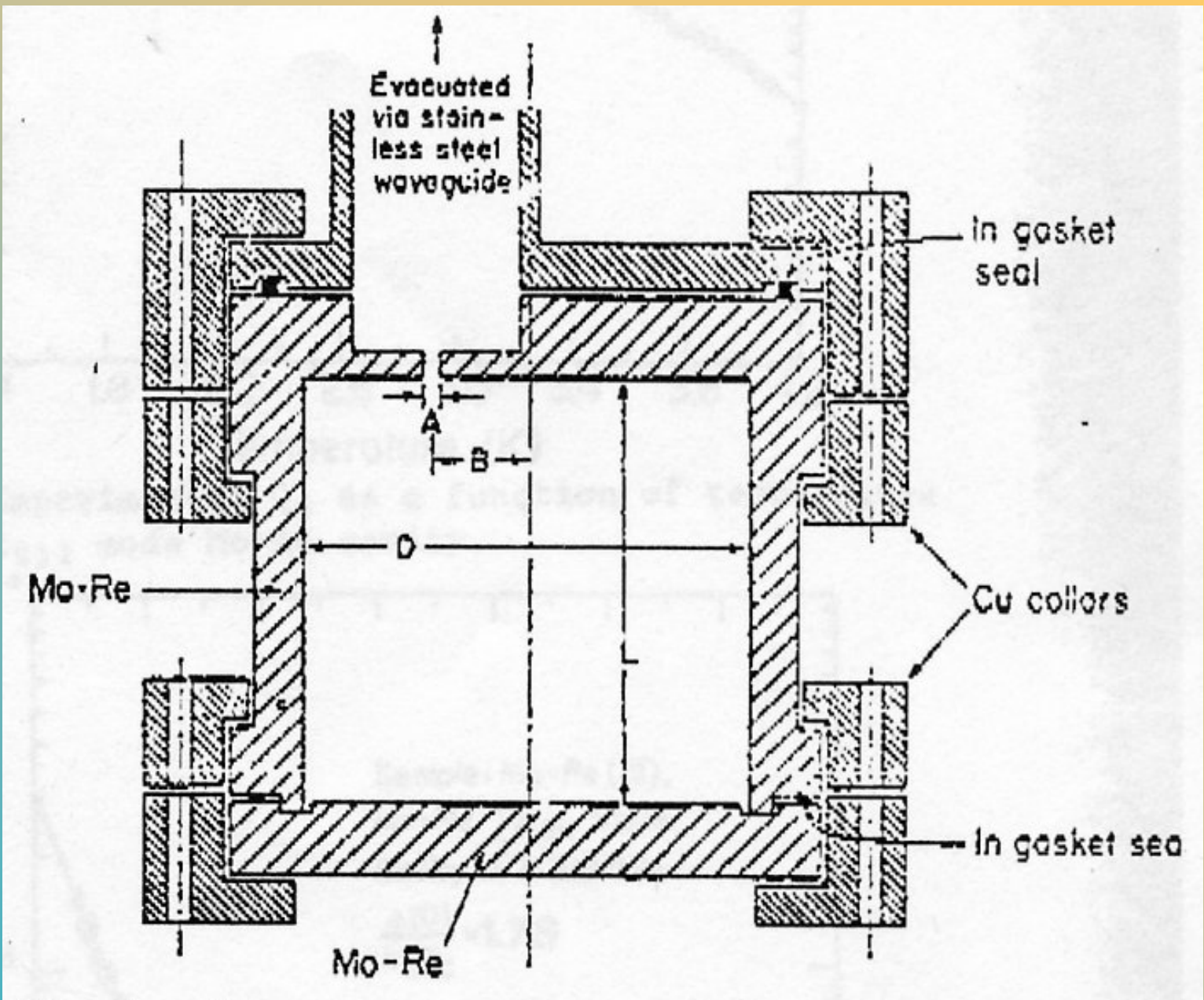


## Molybdenum-Rhenium

Most commonly known as **Moly-Rhenium**, and used extensively throughout many industries -from medicine to defense and pure research to production welding, this material is a less costly alternative to pure rhenium.

Possessing excellent thermal and mechanical properties, **Moly-Rhenium** is used as welding wire, wires for numerous medical applications, components and parts for the aerospace and defense industries, and grids for electronic applications.

<b>Density, g/cm<sup>3</sup></b>	<b>13.52</b>
<b>Melting Point, °C</b>	<b>2550</b>
<b>Thermal Conductivity, W/m at 20°C</b>	<b>36.8</b>
<b>Linear Coefficient of Thermal Expansion, μm/m·K from 20-1000°C</b>	<b>5.7</b>
<b>Ductile Brittle Transition Temperature (DBBT), °C</b>	<b>(-273)-(-173)</b>
<b>Critical Superconducting temperature, K</b>	<b>10.9</b>
<b>Electrical Resistivity, μΩ·m at 20°C</b>	<b>0.220</b>
<b>Elastic Modulus in Tension, GPa</b>	<b>373</b>



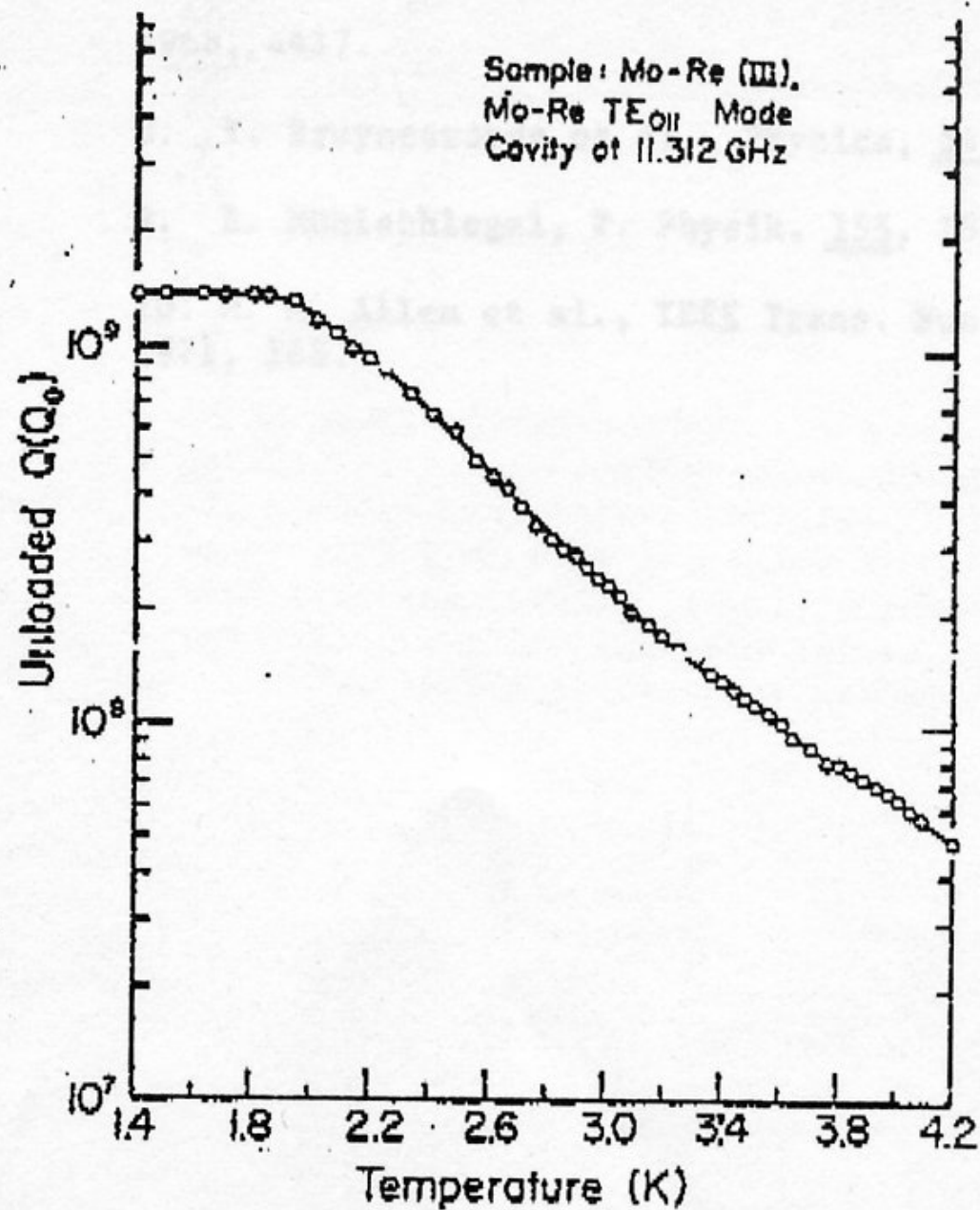


Fig. 4. Experimental  $Q_0$  as a function of temperature for the TE<sub>011</sub> mode Mo-Re cavity.

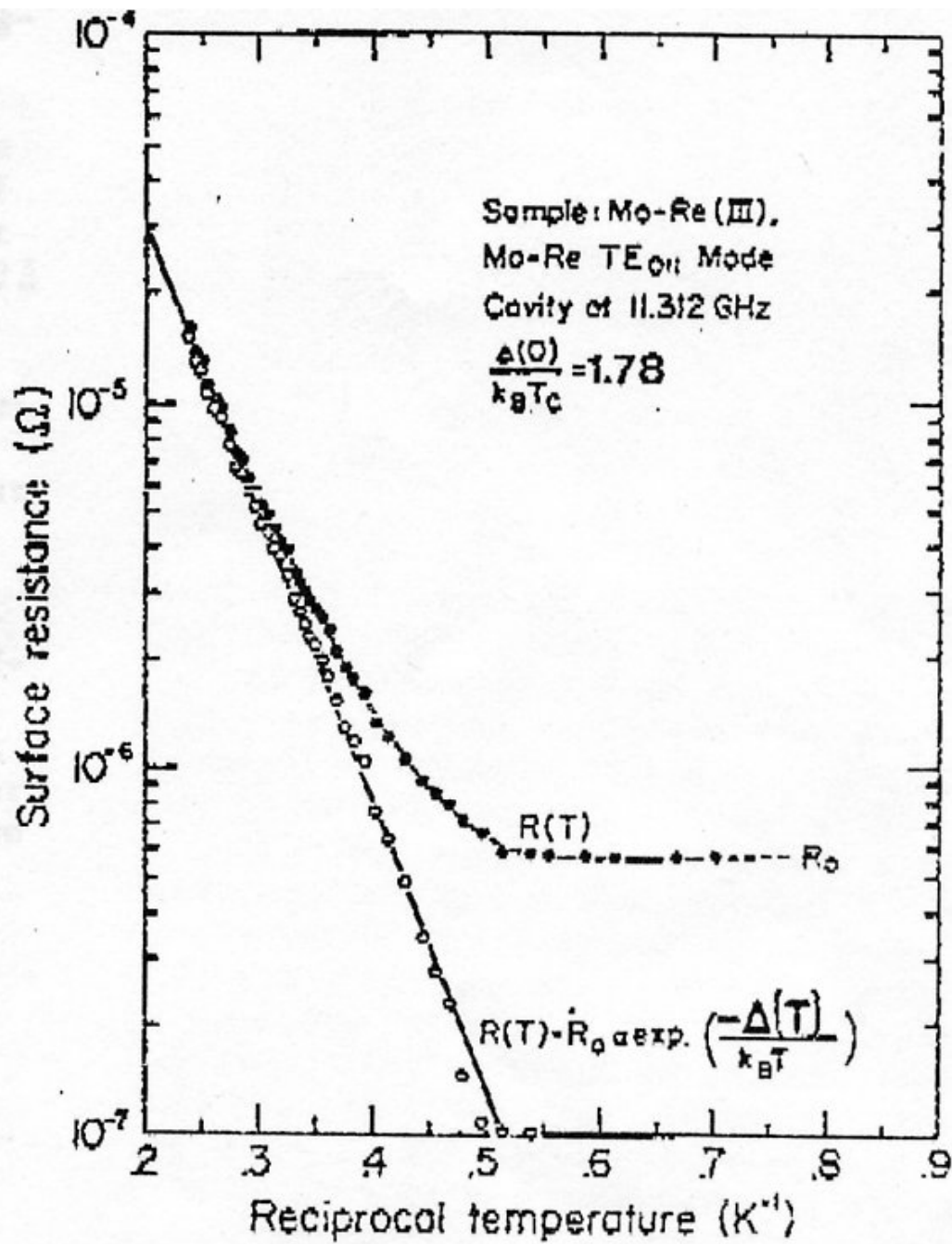


Fig. 5. Experimental surface resistance as a function of reciprocal temperature.



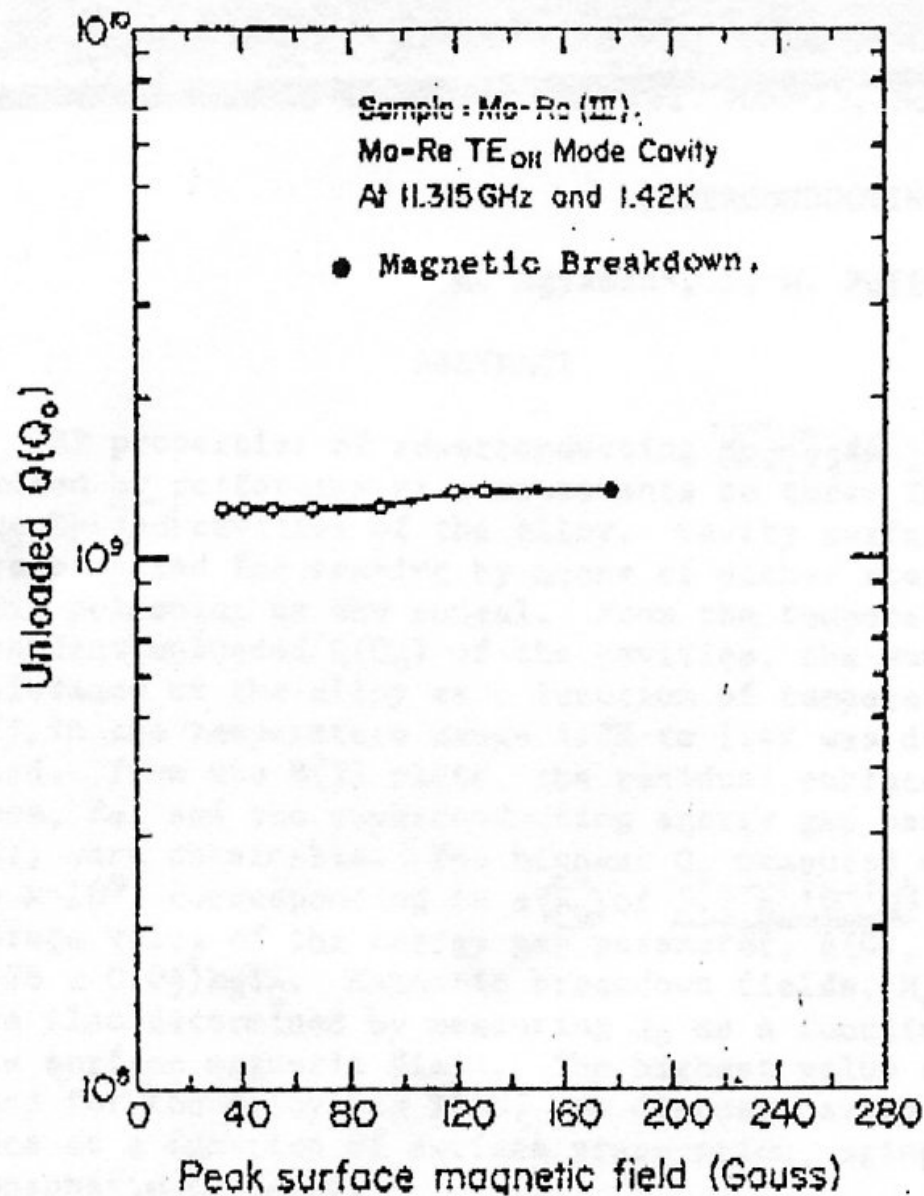


Fig. 6. Example of unloaded Q as a function of Rf magnetic field.

(After Yasaitis and Rose, 1975)



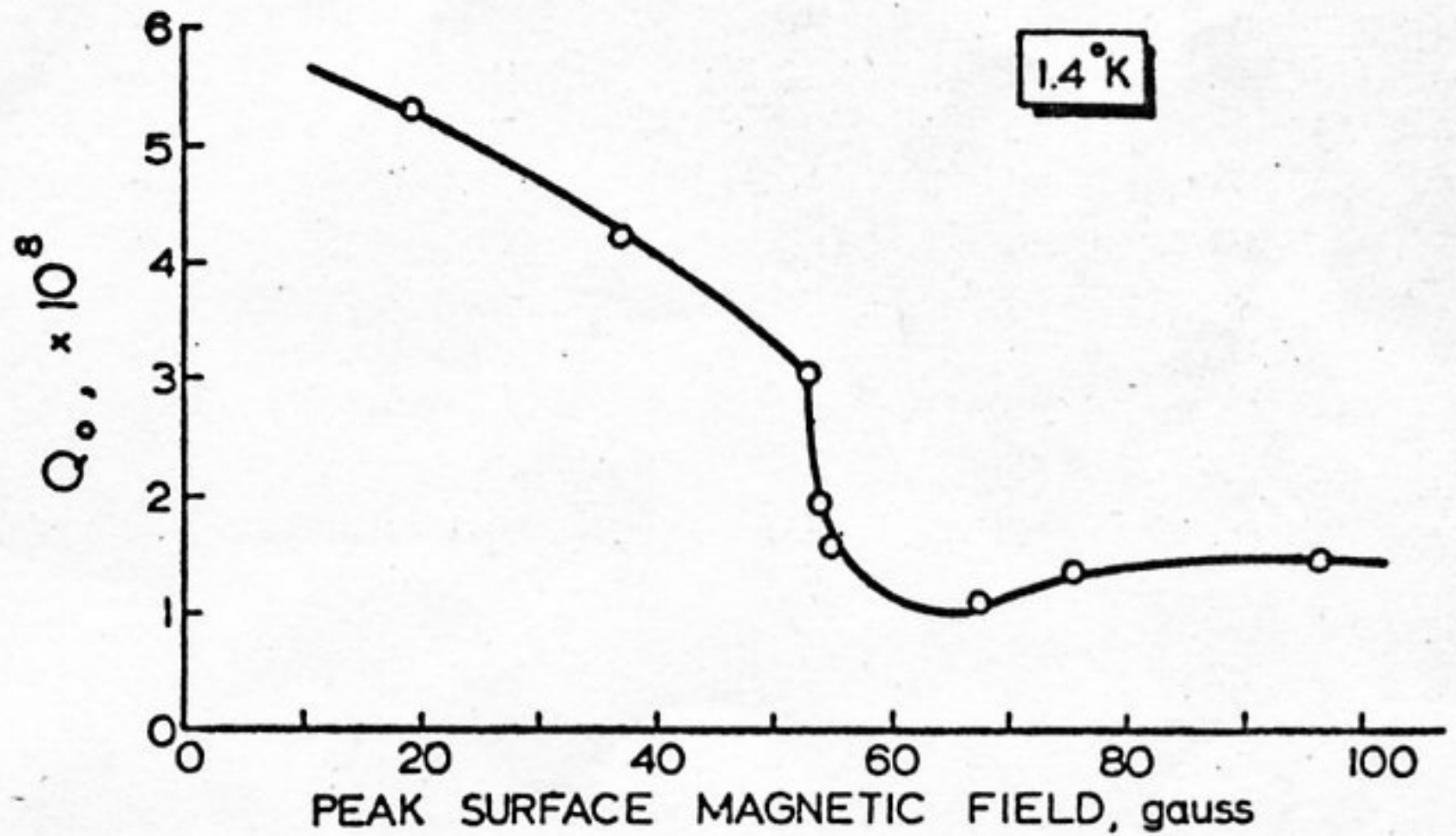
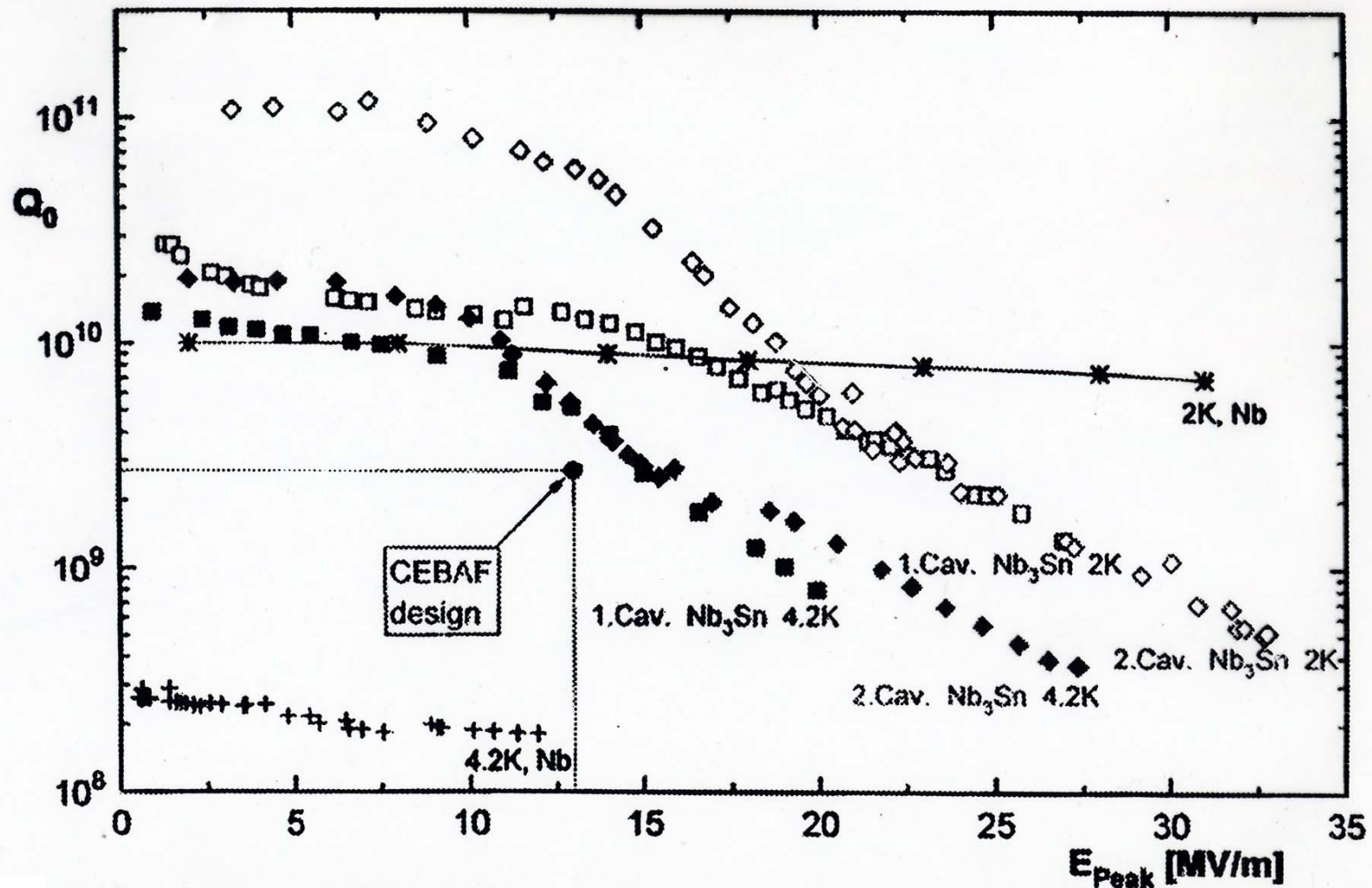
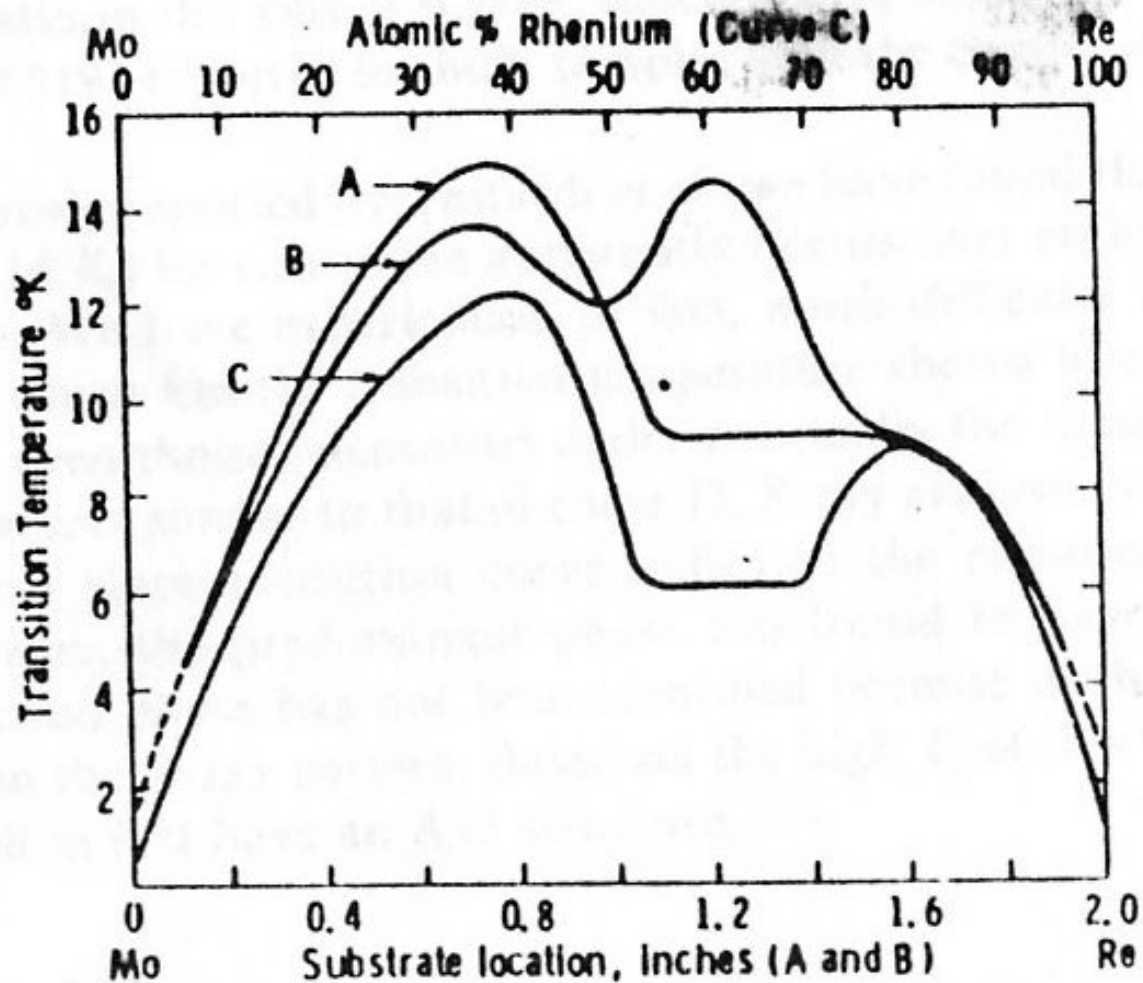


Fig. 2. High-power measurement on composite (Nb + Mo-Re) cavity.

# Nb<sub>3</sub>Sn 1.5GHz cavity made at Wuppertal by Sn vapour phase diffusion



Q vs.  $E_{peak}$  of the first two Nb<sub>3</sub>Sn-coated 1.5 GHz single-cell cavities in comparison to pure Nb at 4.2 K and 2 K from CEBAF.



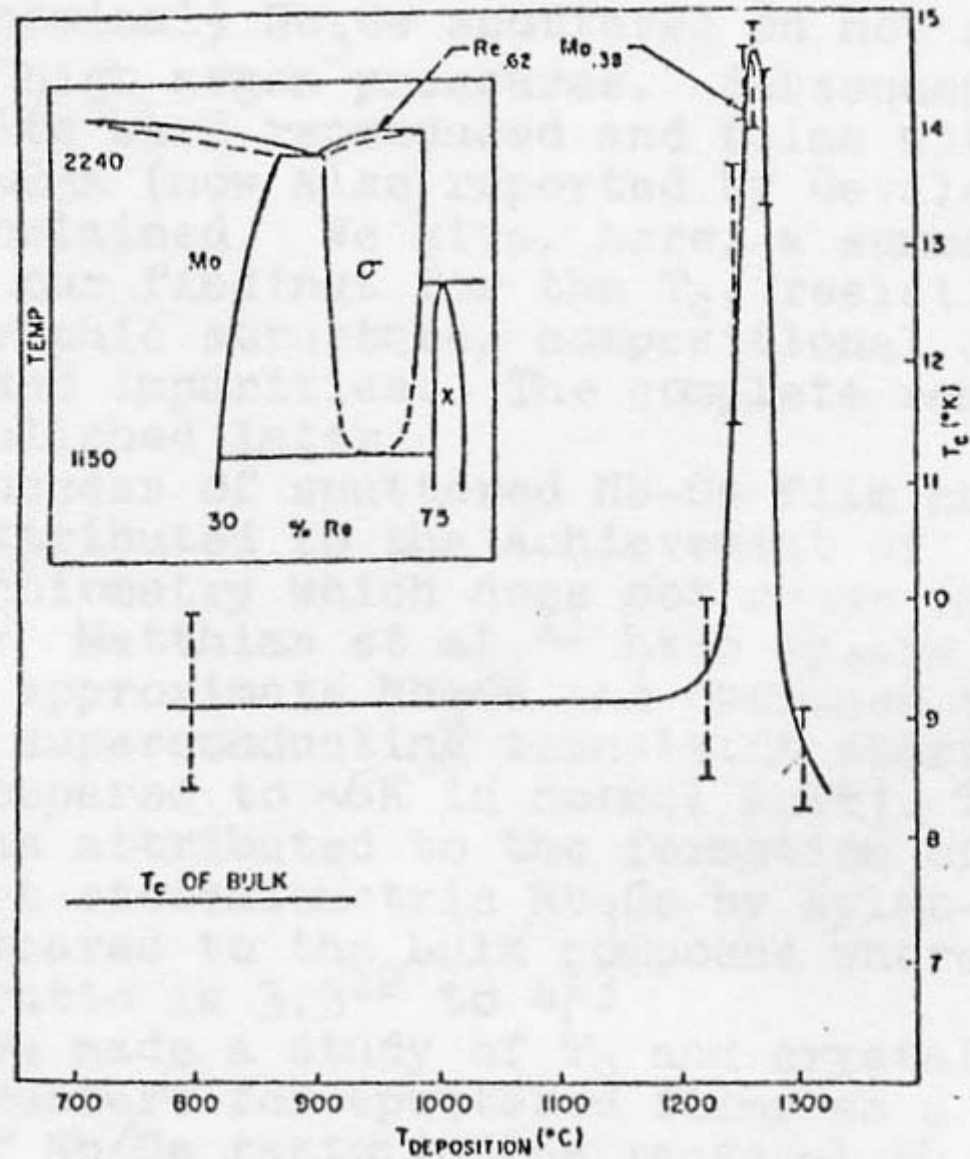
Curve A - Films sputtered at  $\sim 500 \text{ \AA}/\text{min}$  onto  $1000 \text{ }^\circ\text{C}$  substrates

Curve B - Films sputtered at  $\sim 1000 \text{ \AA}/\text{min}$  onto  $1200 \text{ }^\circ\text{C}$  substrates

Curve C - Bulk Mo-Re samples

From Blaugher et al

# $\text{Mo}_{38}\text{Re}_{62}$ (after Testardi)



(The author communicates that the Temperature was 150 C lower than reported in the picture)



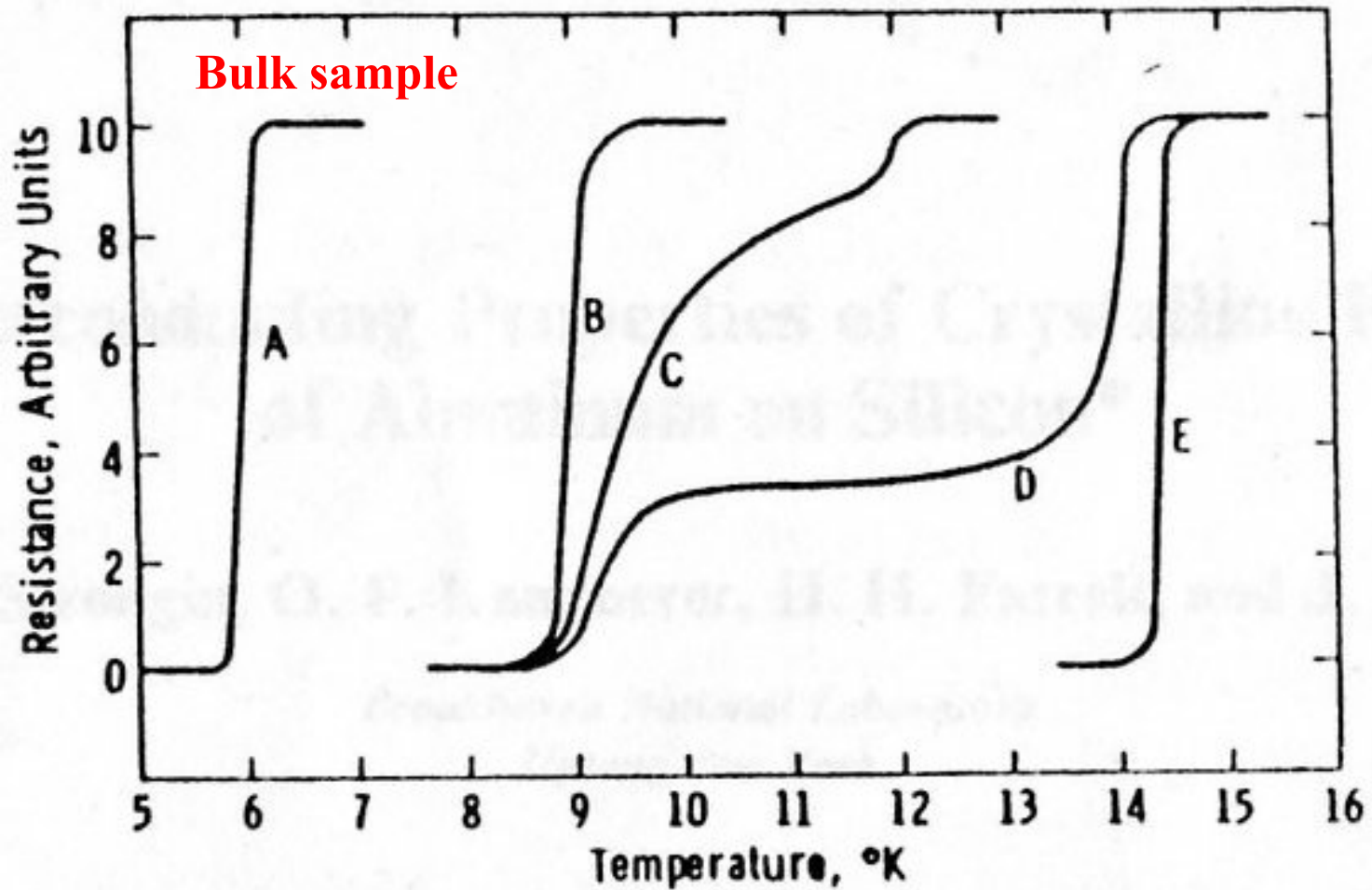


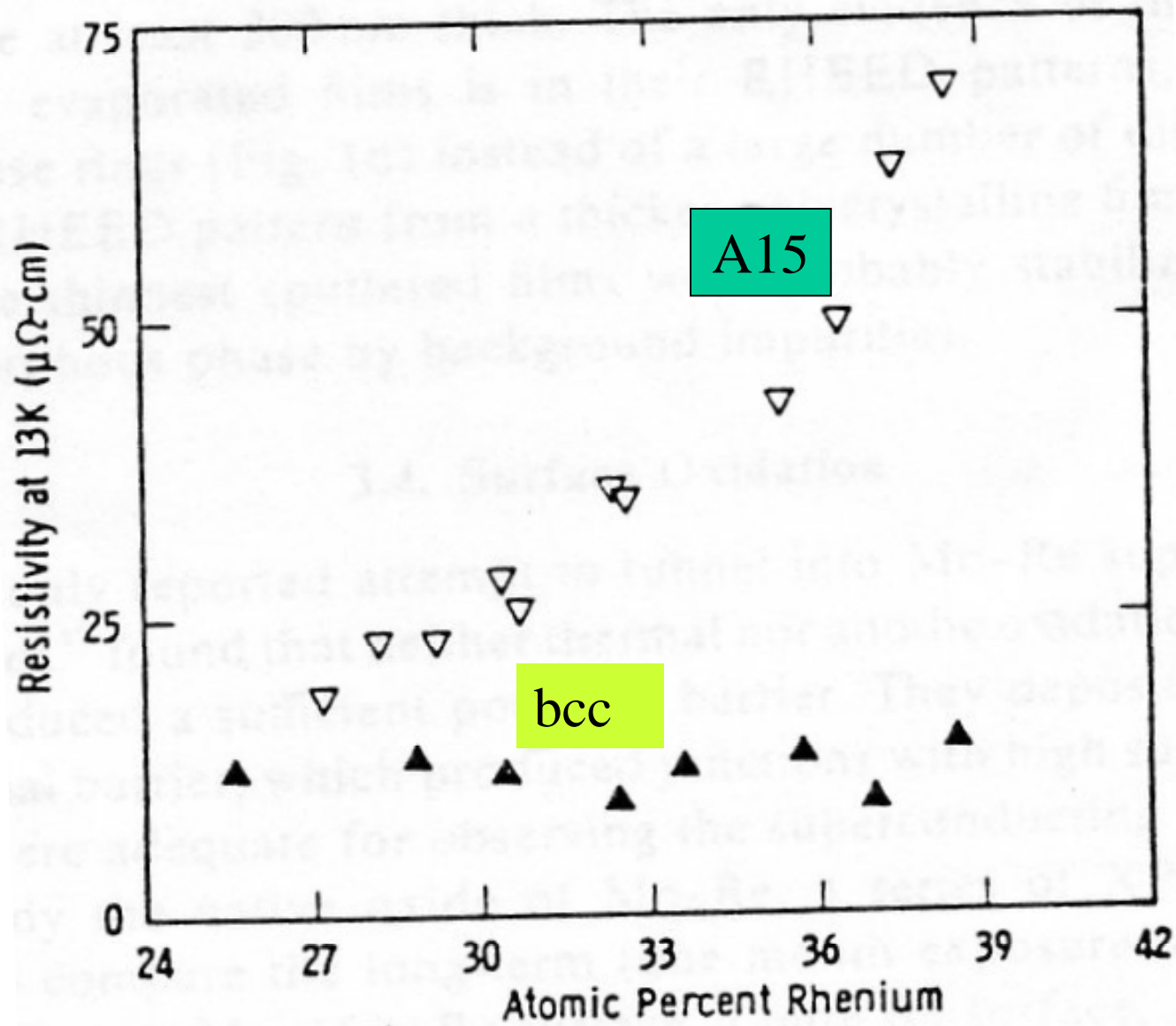
Fig. 3.  $T_c$ 's of Mo-Re alloy samples all of the approximate composition  $\text{Mo}_{40}\text{Re}_{60}$ . A—Bulk sample<sup>4</sup>; B, C, D, E—thin films sputtered at  $\sim 1000 \text{ \AA}/\text{min}$  onto  $600^\circ\text{C}$ ,  $750^\circ\text{C}$ ,  $1150^\circ\text{C}$ , and  $1200^\circ\text{C}$  substrates, respectively.



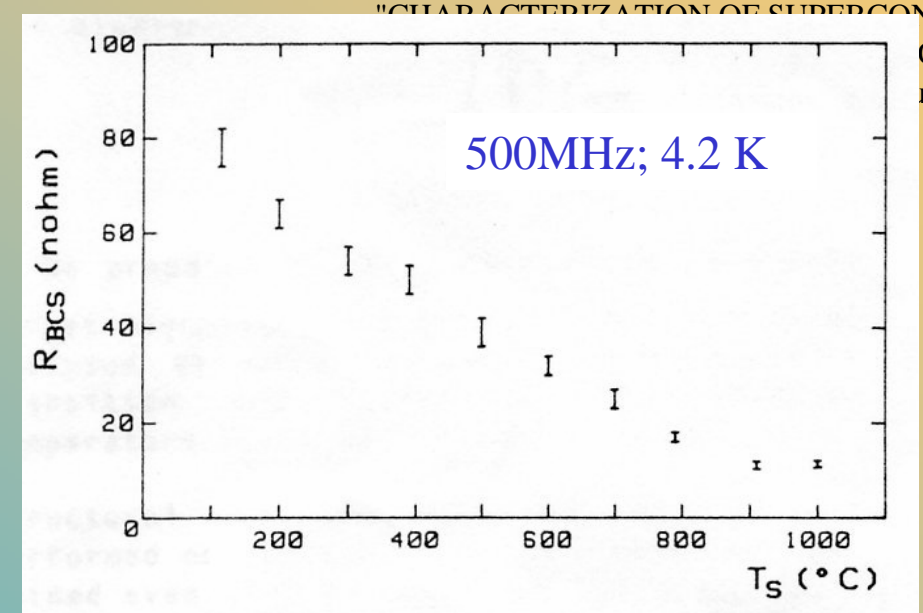
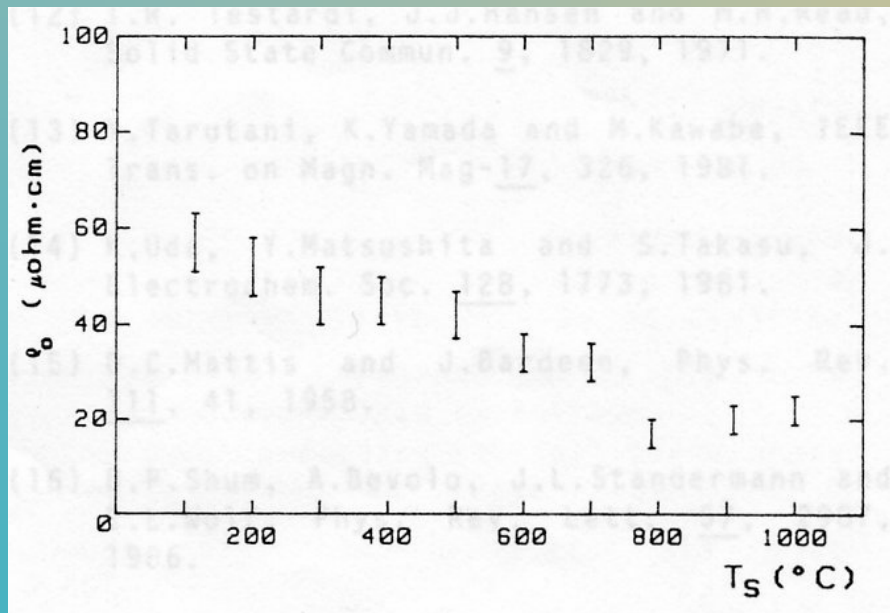
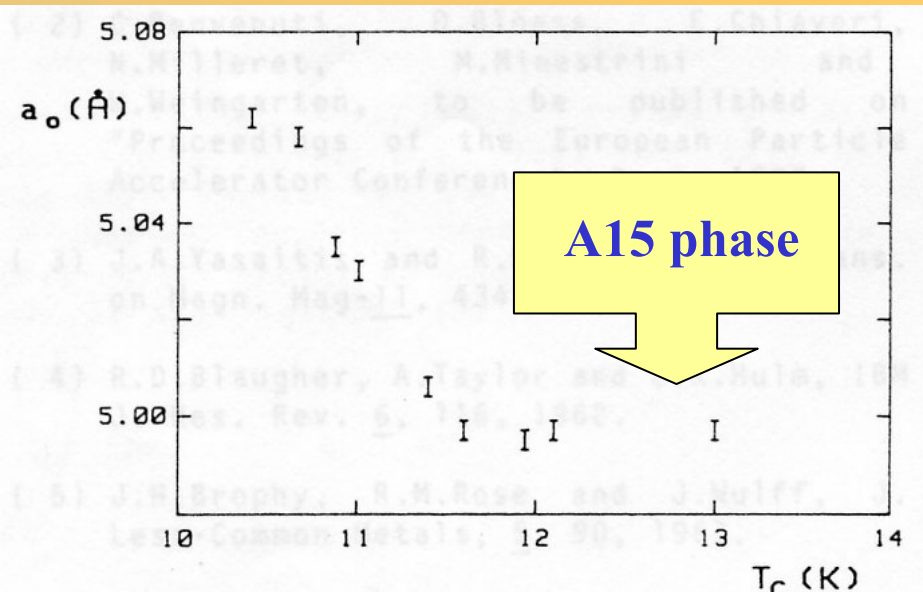
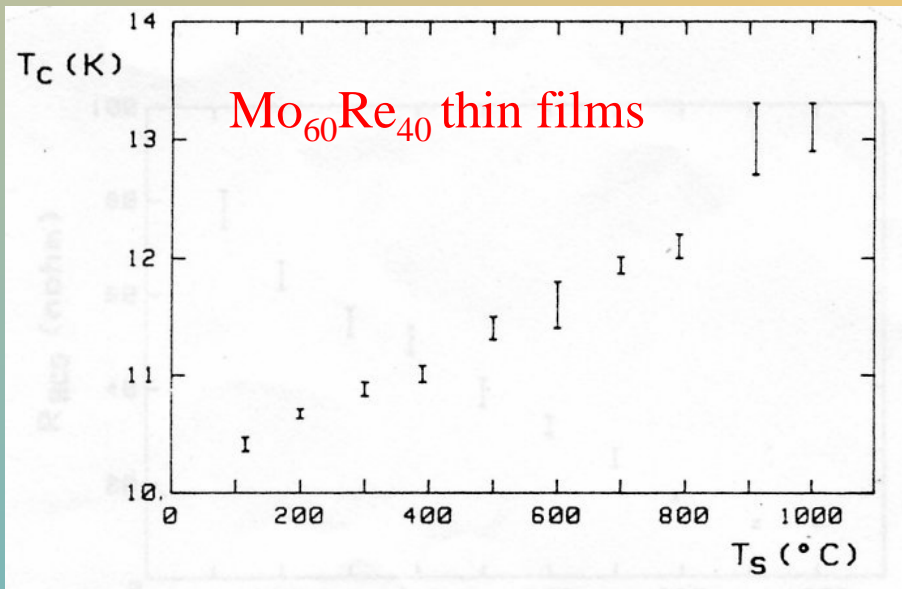
$$R_S = R_S (e^{-sT_c/2T})$$

Measured Parameters of VI-B, VII-B Superconductors

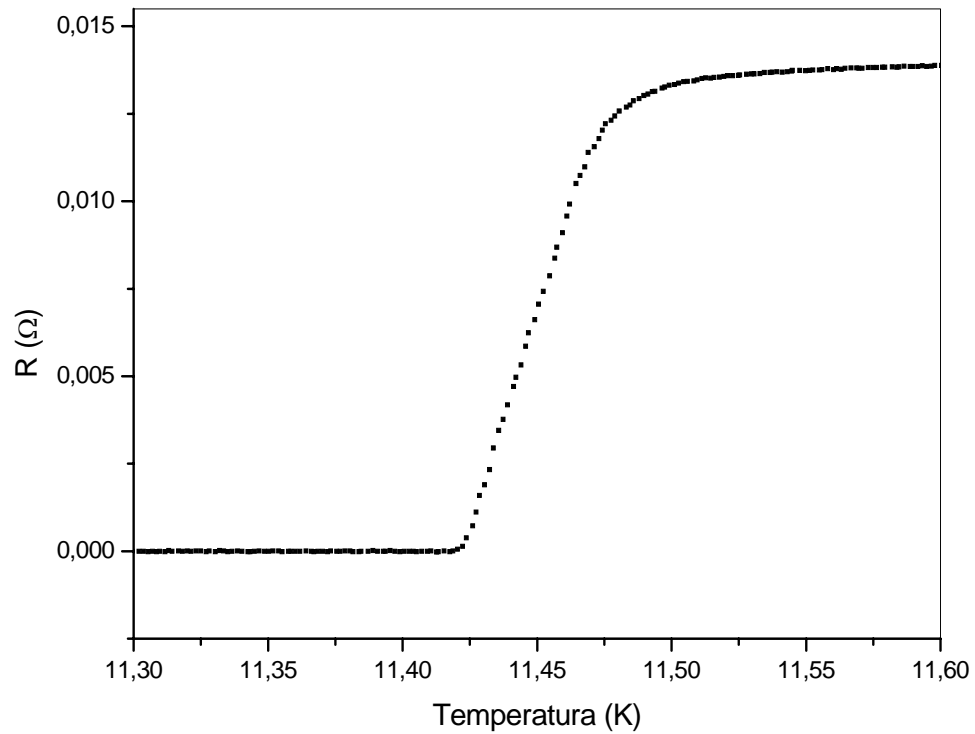
Compound	$\gamma$ (mJ/g-atom-K <sup>2</sup> )	$\beta$ (mJ/g-atom-K <sup>4</sup> )	$\delta$ (mJ/g-atom-K <sup>6</sup> )	$\theta_D$ (K)	$2\Delta/kT_c$	$T_c$ onset	Struct.
Mo <sub>0.6</sub> Re <sub>0.4</sub>	4.55	.05639	.0001535	325	5.0	12.0	bcc
	4.44	.0481	-	340	-	12.6	bcc
Mo <sub>0.4</sub> Re <sub>0.6</sub>	3.60	.04881	0	342	3.4	6.0	tetr.
	3.2	-	-	355	-	6.49	tetr.
Mo <sub>0.42</sub> Re <sub>0.58</sub>	3.31	-	-	351	2.8	6.35	tetr.
Mo <sub>0.23</sub> Re <sub>0.77</sub>	3.8	-	-	272	3.0	9.25	A-12
W <sub>0.65</sub> Re <sub>0.35</sub>	2.49	.06599	0	309	3.1	6.75	bcc
W <sub>0.80</sub> Re <sub>0.20</sub>	2.2	-	-	359	-	-	bcc
W <sub>0.75</sub> Re <sub>0.25</sub>	2.3	-	-	351	-	-	bcc
W <sub>0.59</sub> Re <sub>0.50</sub>	2.69	-	-	327	3.3	5.12	tetr.
Mo <sub>0.18</sub> Tc <sub>0.82</sub>	8.	.03396	.0002317	385	3.6	13.7	hcp



Normal-state resistivity plotted as a function of Re composition for films with A15 and  $\alpha$ -Mo structures.

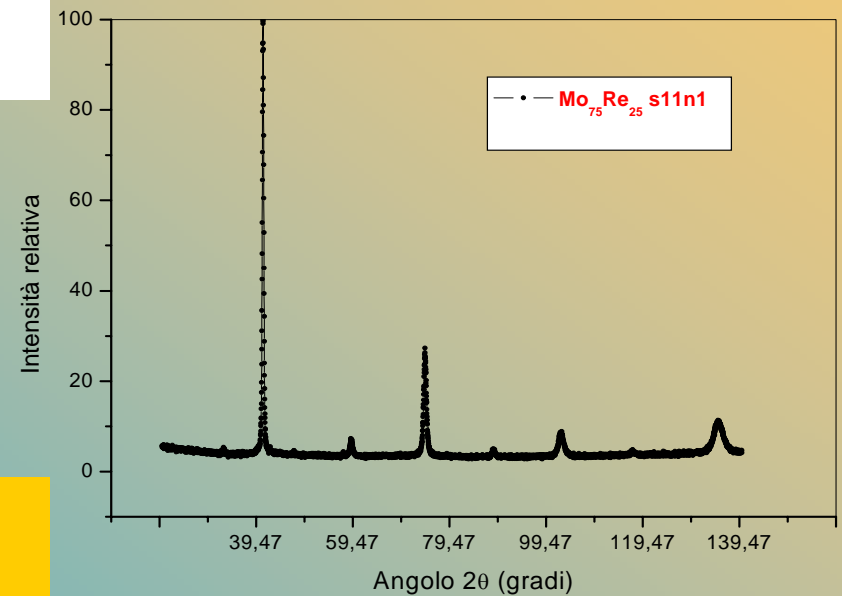


A.Andreone, A.Barone, A.Di Chiara, G.Mascolo, V.Palmieri, G.Peluso, U.Scotti, "Mo-Re Superconducting Thin Films by Single Target Magnetron Sputtering", **IEEE Trans. Mag.**, 25, 2, (1989) 1972



Sputtered films from  
 $\text{Mo}_{75}\text{Re}_{25}$  arc melted target

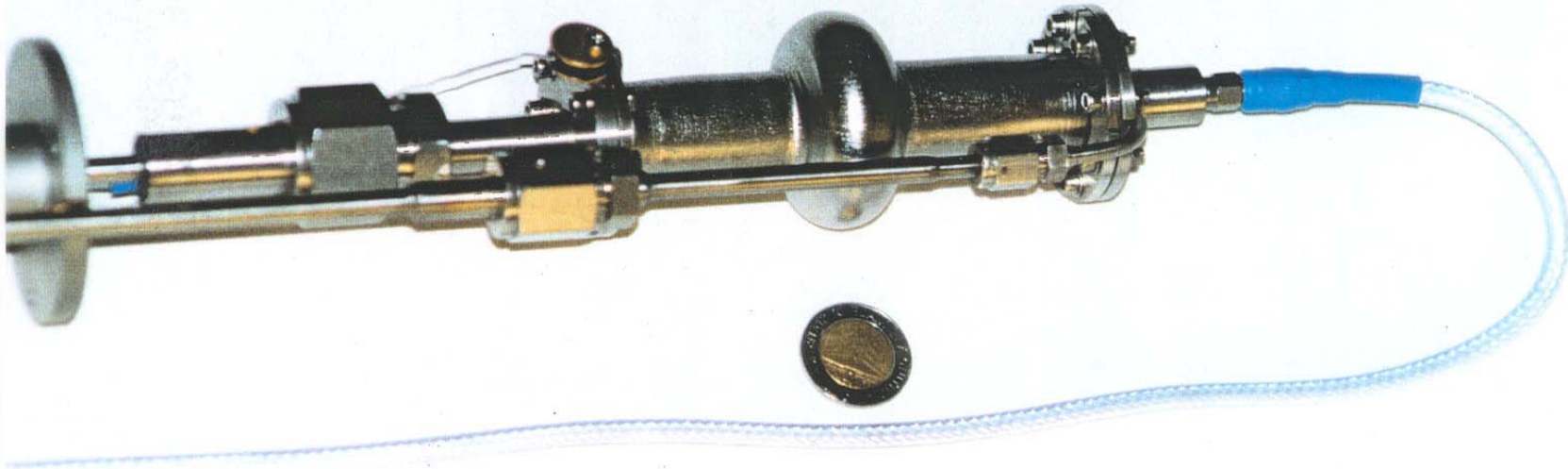
$$\Delta T_C = 0.02 \text{ K}$$



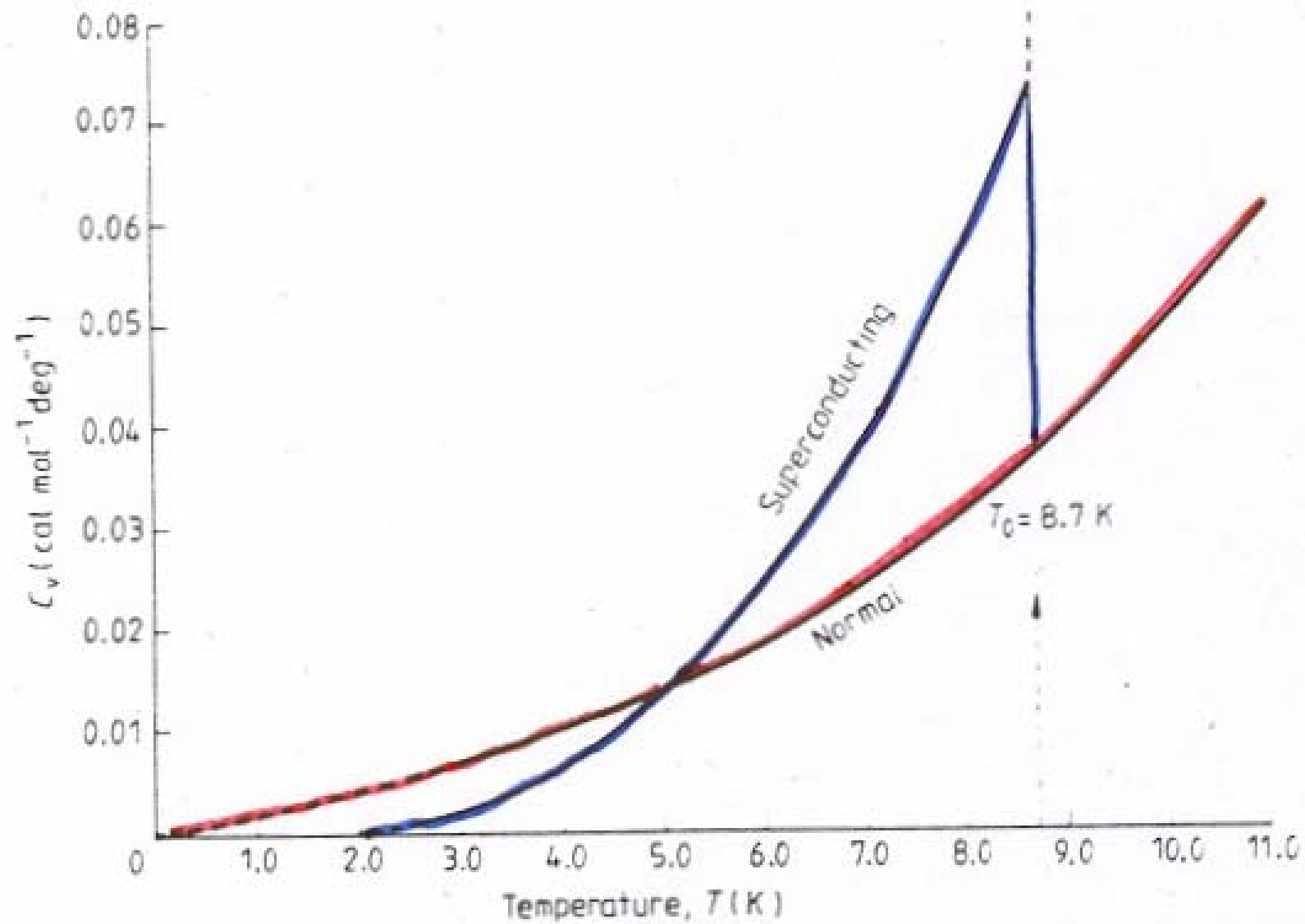
Silvia Deambrosis, Thesis 2004,  
Material Science Dept, Padua University

# A 6 GHz seamless cavity

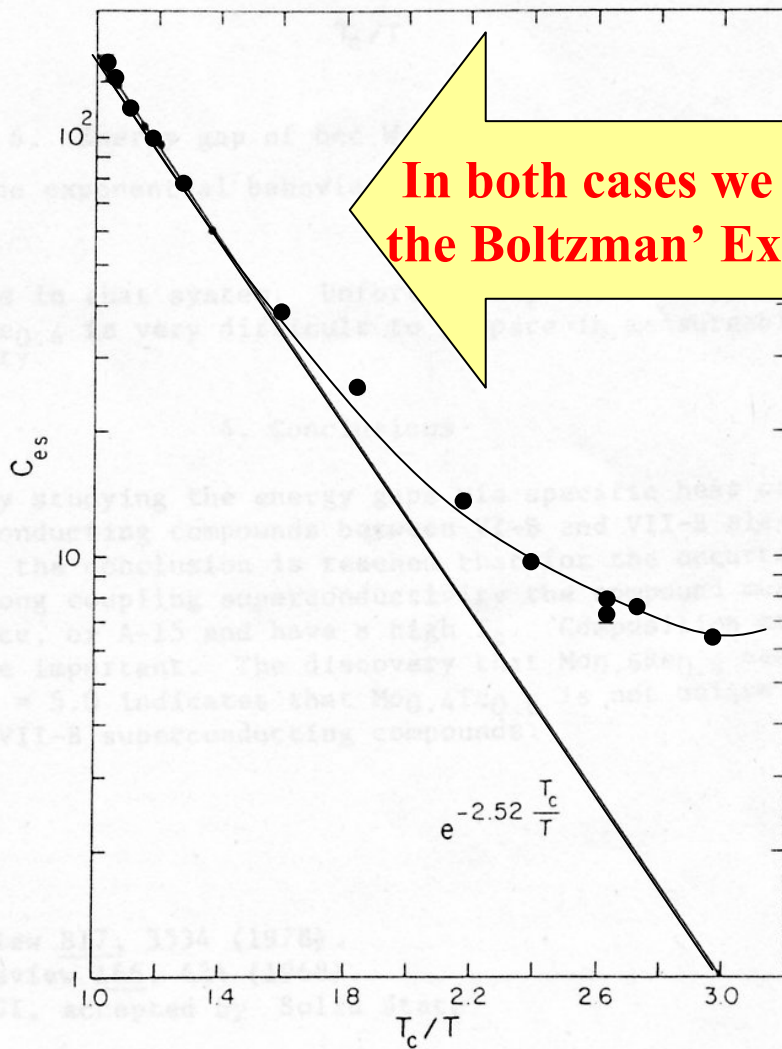
A cheap way to fabricate samples for RF properties from Nb retails  
15 minutes of fabrication time, including flanges,







## Specific heat measurement



**In both cases we measure the Boltzman' Exponential**

## Surface Resistance measurement

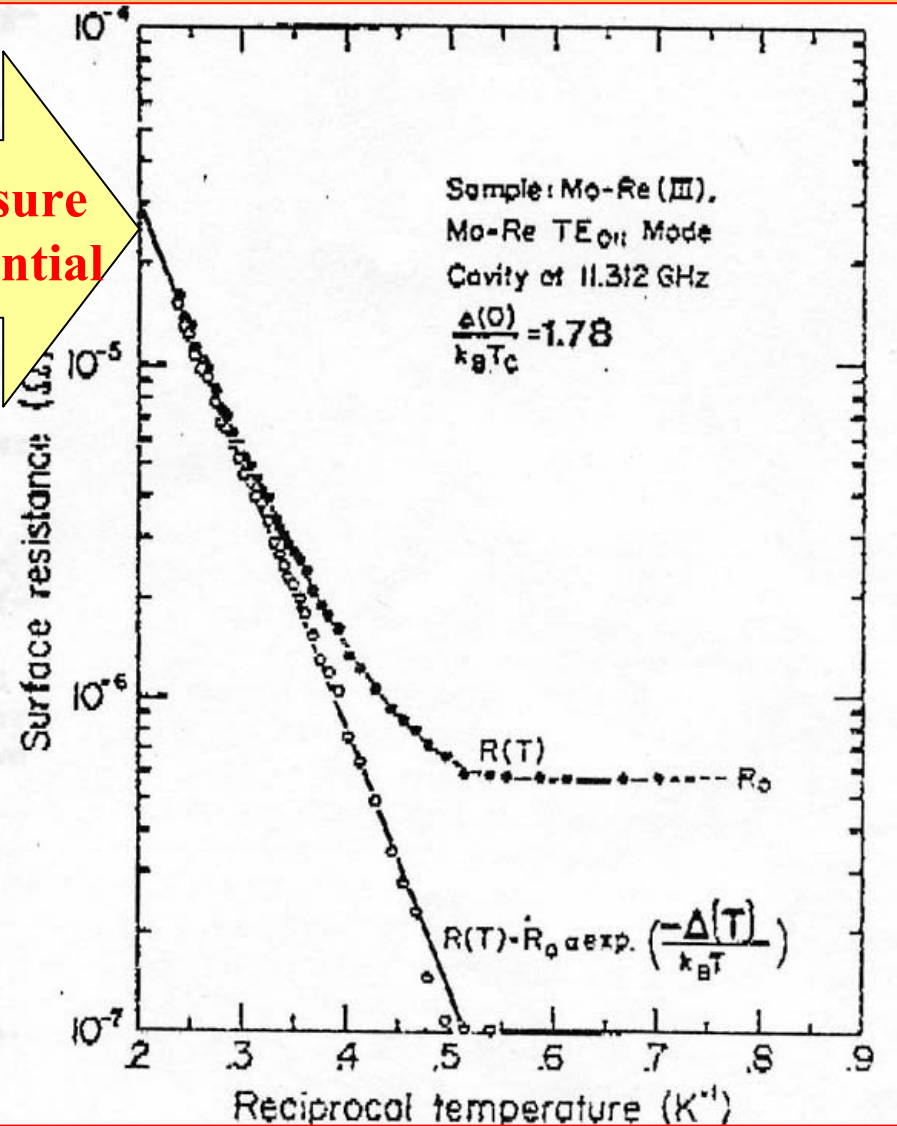


Figure 4. Energy gap of bcc  $MO_{0.6}Re_{0.4}$ , derived from the exponential behaviour of  $C_{es}$  below  $T_c$ .